1/3-Inch Wide-VGA CMOS Digital Image Sensor

MT9V032L12STM ES (Monochrome, Pb-free)
MT9V032L12STC ES (Color, Pb-free)

For the latest data sheet revision, refer to Micron's Web site: www.micron.com/imaging

Features

- Micron® DigitalClarity® CMOS imaging technology
- Array format: Wide-VGA, active 752H x 480V (360,960 pixels)
- Global shutter photodiode pixels; simultaneous integration and readout
- Monochrome or color: Near_IR enhanced performance for use with non-visible NIR illumination
- Readout modes: progressive or interlaced
- Shutter efficiency: >99%
- Simple two-wire serial interface
- Register Lock capability
- Window Size: User programmable to any smaller format (QVGA, CIF, QCIF, etc.). Data rate can be maintained independent of window size
- Binning: 2 x 2 and 4 x 4 of the full resolution
- ADC: On-chip, 10-bit column-parallel (option to operate in 12-bit to 10-bit companding mode)
- Automatic Controls: Auto exposure control (AEC) and auto gain control (AGC); variable regional and variable weight AEC/AGC
- Support for four unique serial control register IDs to control multiple imagers on the same bus
- Data output formats:
  - Single sensor mode:
    10-bit parallel/stand-alone
    8-bit or 10-bit serial LVDS
  - Stereo sensor mode:
    Interspersed 8-bit serial LVDS

Applications

- Security
- High Dynamic Range Imaging
- Unattended surveillance
- Stereo vision
- Video as input
- Machine vision
- Automation

Table 1: Key Performance Parameters

Parameter	Value
Optical format	1/3-inch
Active imager size	4.51mm(H) x 2.88mm(V) 5.35mm diagonal
Active pixels	752H x 480V
Pixel size	6.0µm x 6.0µm
Color filter array	Monochrome or color RGB Bayer pattern
Shutter type	Global shutter—TrueSNAP™
Maximum data rate/ master clock	26.6 MPS/26.6 MHz
Full resolution	752 x 480
Frame rate	60 fps (at full resolution)
ADC resolution	10-bit column-parallel
Responsivity	4.8 V/lux-sec (550nm)
Dynamic range	>55dB linear; >80dB−100dB in HiDy mode
Supply voltage	3.3V ±0.3V (all supplies)
Power consumption	<320mW at maximum data rate; 100µW standby current
Operating temperature	–30°C to +70°C
Packaging	48-pin LLCC

Ordering Information

Table 2: Available Part Numbers

Part Number	Description
MT9V032L12STM ES	48-pin LLCC (mono)
MT9V032L12STC ES	48-pin LLCC (color)
MT9V032L12STMD ES	48-pin LLCC demo kit (mono)
MT9V032L12STMH ES	48-pin LLCC headboard only (mono)
MT9V032L12STCD ES	48-pin LLCC demo kit (color)
MT9V032L12STCH ES	48-pin LLCC headboard only (color)

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General Description

The Micron® Imaging MT9V032 is a 1/3-inch wide-VGA format CMOS active-pixel digital image sensor with global shutter and high dynamic range (HDR) operation. The sensor has specifically been designed to support the demanding interior and exterior security imaging needs, which makes this part ideal for a wide variety of imaging applications in real-world environments.

This wide-VGA CMOS image sensor features DigitalClarity—Micron's breakthrough low-noise CMOS imaging technology that achieves CCD image quality (based on signal-to-noise ratio and low-light sensitivity) while maintaining the inherent size, cost, and integration advantages of CMOS.

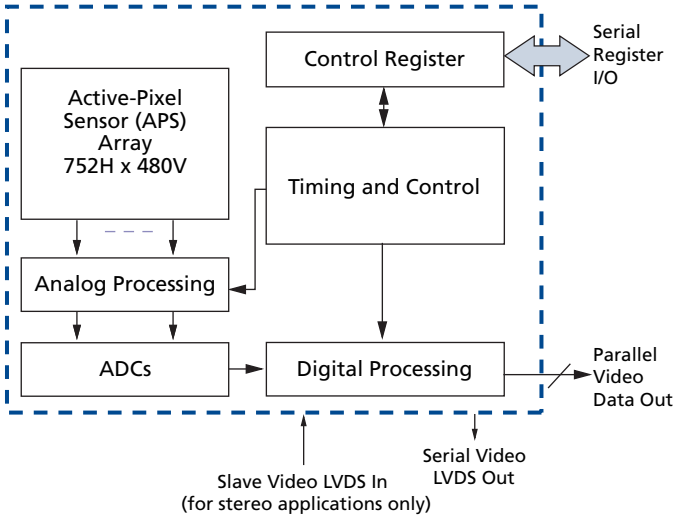
The active imaging pixel array is 752H x 480V. It incorporates sophisticated camera functions on-chip—such as binning 2 x 2 and 4 x 4, to improve sensitivity when operating in smaller resolutions—as well as windowing, column and row mirroring. It is programmable through a simple two-wire serial interface.

The MT9V032 can be operated in its default mode or be programmed for frame size, exposure, gain setting, and other parameters. The default mode outputs a wide-VGA-size image at 60 frames per second (fps).

An on-chip analog-to-digital converter (ADC) provides 10 bits per pixel. A 12-bit resolution companded for 10-bits for small signals can be alternatively enabled, allowing more accurate digitization for darker areas in the image.

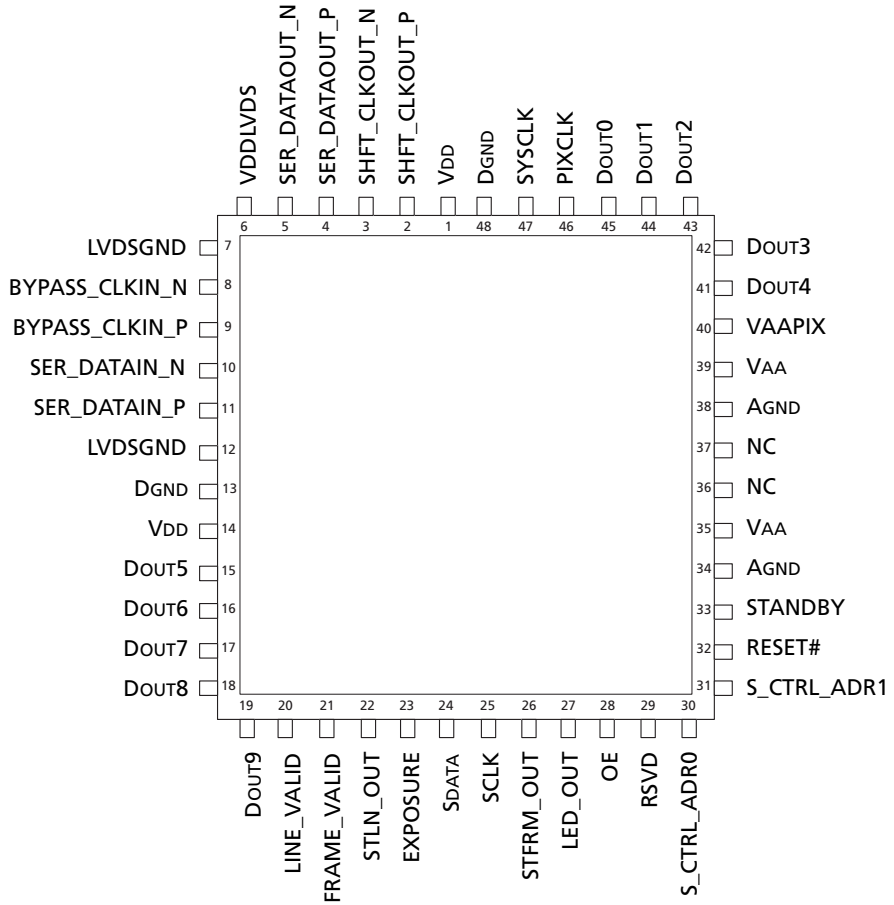
In addition to a traditional, parallel logic output the MT9V032 also features a serial low-voltage differential signaling (LVDS) output. The sensor can be operated in a stereo-camera, and the sensor, designated as a stereo-master, is able to merge the data from itself and the stereo-slave sensor into one serial LVDS stream.

Figure 1: Block Diagram



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Figure 2: 48-Pin LLCC Package Pinout Diagram



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Pin Descriptions

Table 3: Pin Descriptions
Only pins DOUT0 through DOUT9 may be tri-stated.

48-Pin LLCC Numbers	Symbol	Type	Description	Note
29	RSVD	Input	Connect to DGND.	1
10	SER_DATAIN_N	Input	Serial data in for stereoscopy (differential negative). Tie to 1kΩ pull-up (to 3.3V) in non-stereoscopy mode.	
11	SER_DATAIN_P	Input	Serial data in for stereoscopy (differential positive). Tie to DGND in non-stereoscopy mode.	
8	BYPASS_CLKIN_N	Input	Input bypass shift-CLK (differential negative). Tie to 1KΩ pull-up (to 3.3V) in non-stereoscopy mode.	
9	BYPASS_CLKIN_P	Input	Input bypass shift-CLK (differential positive). Tie to DGND in non-stereoscopy mode.	
23	EXPOSURE	Input	Rising edge starts exposure in slave mode.	
25	SCLK	Input	Two-wire serial interface clock. Connect to VDD with 1.5K resistor even when no other two-wire serial interface peripheral is attached.	
28	OE	Input	DOUT enable pad, active HIGH.	2
30	S_CTRL_ADR0	Input	Two-wire serial interface slave address bit 3.	
31	S_CTRL_ADR1	Input	Two-wire serial interface slave address bit 5.	
32	RESET#	Input	Asynchronous reset. All registers assume defaults.	
33	STANDBY	Input	Shut down sensor operation for power saving.	
47	SYSCLK	Input	Master clock (26.6 MHz).	
24	SDATA	I/O	Two-wire serial interface data. Connect to VDD with 1.5K resistor even when no other two-wire serial interface peripheral is attached.	
22	STLN_OUT	I/O	Output in master mode—start line sync to drive slave chip in-phase; input in slave mode.	
26	STFRM_OUT	I/O	Output in master mode—start frame sync to drive a slave chip in-phase; input in slave mode.	
20	LINE_VALID	Output	Asserted when DOUT data is valid.	
21	FRAME_VALID	Output	Asserted when DOUT data is valid.	
15	DOUT5	Output	Parallel pixel data output 5.	
16	DOUT6	Output	Parallel pixel data output 6.	
17	DOUT7	Output	Parallel pixel data output 7.	
18	DOUT8	Output	Parallel pixel data output 8	
19	DOUT9	Output	Parallel pixel data output 9.	
27	LED_OUT	Output	LED strobe output.	
41	DOUT4	Output	Parallel pixel data output 4.	
42	DOUT3	Output	Parallel pixel data output 3.	
43	DOUT2	Output	Parallel pixel data output 2.	
44	DOUT1	Output	Parallel pixel data output 1.	
45	DOUT0	Output	Parallel pixel data output 0.	
46	PIXCLK	Output	Pixel clock out. DOUT is valid on rising edge of this clock.	
2	SHFT_CLKOUT_N	Output	Output shift CLK (differential negative).	
3	SHFT_CLKOUT_P	Output	Output shift CLK (differential positive).	
4	SER_DATAOUT_N	Output	Serial data out (differential negative).	

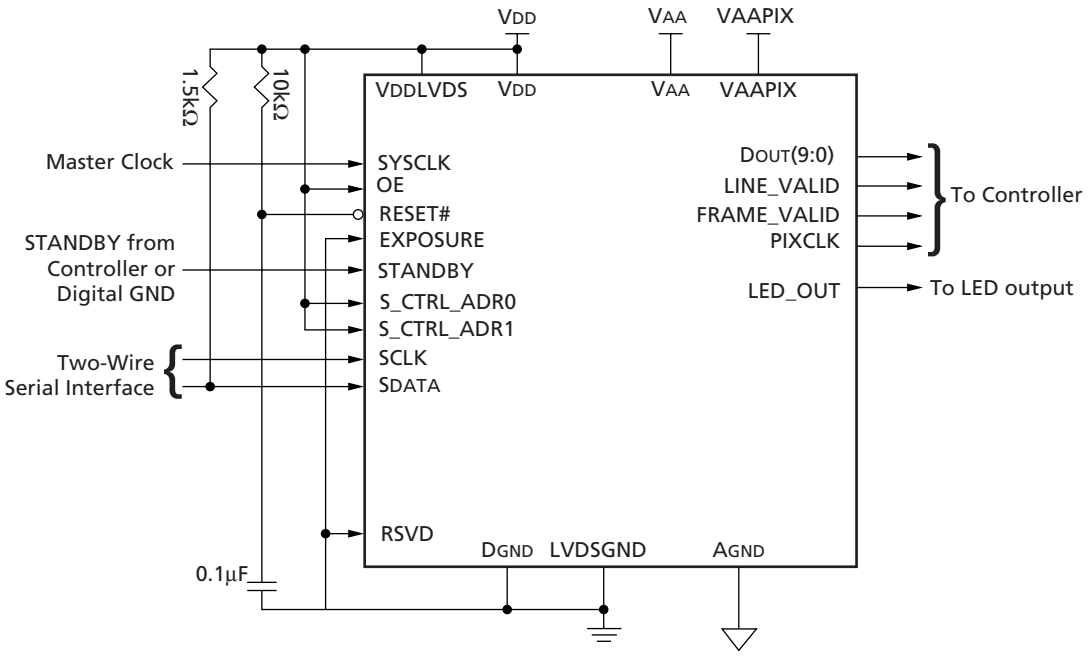
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Table 3: Pin Descriptions (continued)
Only pins DOUT0 through DOUT9 may be tri-stated.

48-Pin LLCC Numbers	Symbol	Type	Description	Note
5	SER_DATAOUT_P	Output	Serial data out (differential positive).	
1, 14	VDD	Supply	Digital power 3.3V.	
35, 39	VAA	Supply	Analog power 3.3V.	
40	VAAPIX	Supply	Pixel power 3.3V.	
6	VDDLVDS	Supply	Dedicated power for LVDS pads.	
7, 12	LVDSGND	Ground	Dedicated GND for LVDS pads.	
13, 48	DGND	Ground	Digital GND.	
34, 38	AGND	Ground	Analog GND.	
36, 37	NC	NC	No connect.	3

Notes:
1. Pin 29 (RSVD) must be tied to GND.
2. Output Enable (OE) tri-states signals DOUT0–DOUT9. No other signals are tri-stated with OE.
3. No connect. These pins must be left floating for proper operation.

Figure 3: Typical Configuration (Connection)—Parallel Output Mode



Note: LVDS signals are to be left floating.

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Pixel Data Format

Pixel Array Structure

The MT9V032 pixel array is configured as 782 columns by 492 rows, shown in Figure 4. The left 26 columns and the top eight rows of pixels are optically black and can be used to monitor the black level. The black row data is used internally for the automatic black level adjustment. However, the middle four black rows can also be read out by setting the sensor to raw data output mode. There are 753 columns by 481 rows of optically active pixels. The active area is surrounded with optically transparent dummy columns and rows to improve image uniformity within the active area. One additional active column and active row are used to allow horizontally and vertically mirrored readout to also start on the same color pixel.

Figure 4: Pixel Array Description

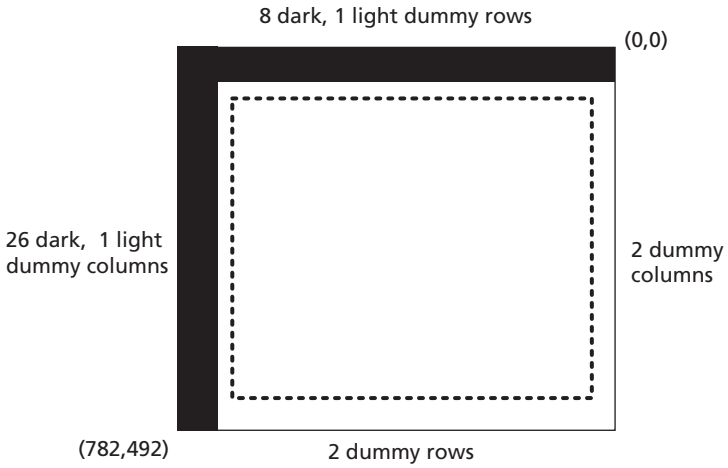
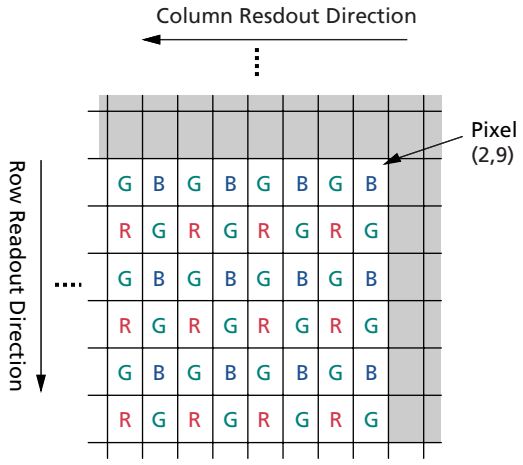


Figure 5: Pixel Color Pattern Detail (Top Right Corner)



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Color Device Limitations

The color version of the MT9V032 does not support or offers reduced performance for the following functionalities.

Pixel Binning

Pixel binning is done on immediate neighbor pixels only, no facility is provided to skip pixels according to a Bayer pattern. Therefore, the result of binning combines pixels of different colors.

Interlaced Readout

Interlaced readout yields one field consisting only of red and green pixels and another consisting only of blue and green pixels. This is due to the Bayer pattern of the CFA.

Automatic Black Level Calibration

When the color bit is set (R0x9F[2] = 1), the sensor uses a separate and independent black level correction value for each color. To use the same calibration value for all colors, the color bit should be cleared.

Other Limiting Factors

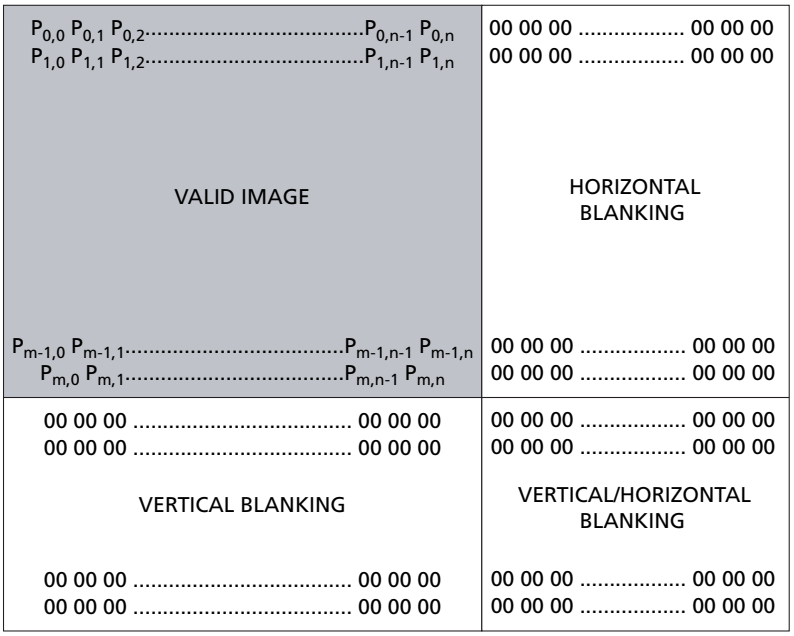
Black level correction and row-wise noise correction is applied uniformly to each color. Automatic exposure and gain control calculations are made based on all three colors, not just the green luma channel. High dynamic range does operate; however, Micron strongly recommends limiting use to linear operation if good color fidelity is required.

Output Data Format

The MT9V032 image data can be read out in a progressive scan or interlaced scan mode. Valid image data is surrounded by horizontal and vertical blanking, as shown in Figure 6. The amount of horizontal and vertical blanking is programmable through R0x05 and R0x06, respectively. LINE_VALID is HIGH during the shaded region of the figure. See “Output Data Timing” on page 7 for the description of FRAME_VALID timing.

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Figure 6: Spatial Illustration of Image Readout

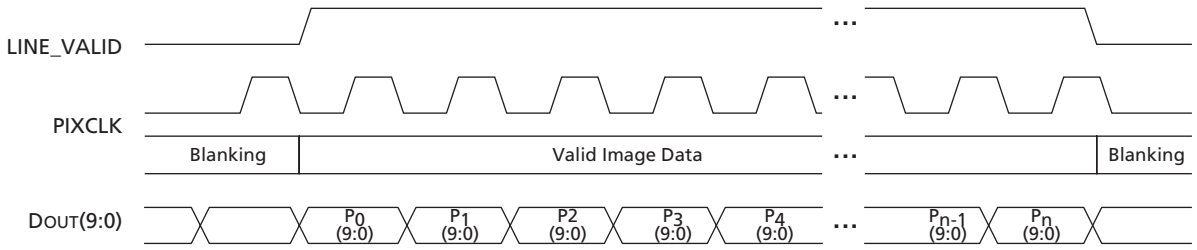


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Output Data Timing

The data output of the MT9V032 is synchronized with the PIXCLK output. When LINE_VALID is HIGH, one 10-bit pixel datum is output every PIXCLK period.

Figure 7: Timing Example of Pixel Data



The PIXCLK is a nominally-inverted version of the master clock (SYSCLK). This allows PIXCLK to be used as a clock to latch the data. However, when column bin 2 is enabled, the PIXCLK is HIGH for one complete master clock master period and then LOW for one complete master clock period; when column bin 4 is enabled, the PIXCLK is HIGH for two complete master clock periods and then LOW for two complete master clock periods. It is continuously enabled, even during the blanking period. Setting R0x74 bit[4] = 1 causes the MT9V032 to invert the polarity of the PIXCLK.

The parameters P1, A, Q and P2 in Figure 8 are defined in Table 4.

Figure 8: Row Timing and FRAME_VALID/LINE_VALID Signals

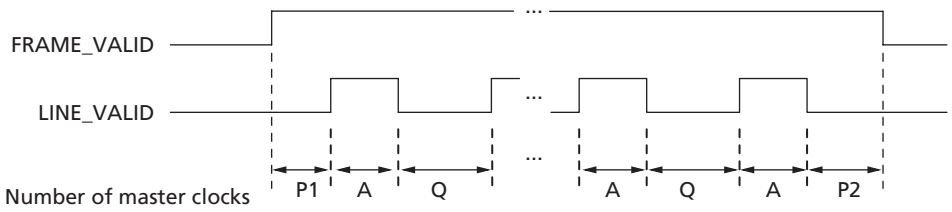


Table 4: Frame Time

Parameter	Name	Equation	Default Timing at 26.66 MHz
A	Active data time	R0x04	752 pixel clocks = 752 master = 28.20µs
P1	Frame start blanking	R0x05 - 23	71 pixel clocks = 71master = 2.66µs
P2	Frame end blanking	23 (fixed)	23 pixel clocks = 23 master = 0.86µs
Q	Horizontal blanking	R0x05	94 pixel clocks = 94 master = 3.52µs
A+Q	Row time	R0x04 + R0x05	846 pixel clocks = 846 master = 31.72µs

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Table 4: Frame Time

Parameter	Name	Equation	Default Timing at 26.66 MHz
V	Vertical blanking	(R0x06) x (A + Q) + 4	38,074 pixel clocks = 38,074 master = 1.43ms
Nrows x (A + Q)	Frame valid time	(R0x03) × (A + Q)	406,080 pixel clocks = 406,080 master = 15.23ms
F	Total frame time	V + (Nrows x (A + Q))	444,154 pixel clocks = 444,154 master = 16.66ms

Sensor timing is shown above in terms of pixel clock and master clock cycles (refer to Figure 7 on page 7). The recommended master clock frequency is 26.66 MHz. The vertical blanking and total frame time equations assume that the number of integration rows (bits 11 through 0 of R0x0B) is less than the number of active rows plus blanking rows minus overhead rows (R0x03 + R0x06 - 2). If this is not the case, the number of integration rows must be used instead to determine the frame time, as shown in Table 5. In this example it is assumed that R0x0B is programmed with 523 rows. For Simultaneous Mode, if the exposure time register (0x0B) exceeds the total readout time, then vertical blanking is internally extended automatically to adjust for the additional integration time required. This extended value is **not** written back to R0x06 (vertical blanking). R0x06 can be used to adjust frame to frame readout time. This register does not effect the exposure time but it may extend the readout time.

Table 5: Frame Time—Long Integration Time

Parameter	Name	Equation (Number of Master Clock Cycles)	Default Timing at 26.66 MHz
V′	Vertical blanking (long integration time)	(R0x0B + 2 - R0x03) × (A + Q) + 4	38,074 pixel clocks = 38,074 master = 1.43ms
F″	Total frame time (long integration time)	(R0x0B + 2) × (A + Q) + 4	444,154 pixel clocks = 444,154 master = 16.66ms

Note: The MT9V032 uses column parallel analog-digital converters, thus short row timing is not possible. The minimum total row time is **660 columns** (horizontal width + horizontal blanking). The minimum horizontal blanking is 43. When the window width is set below 617, horizontal blanking must be increased. The frame rate will not increase for row times less than 660 columns.

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Serial Bus Description

Registers are written to and read from the MT9V032 through the two-wire serial interface bus. The MT9V032 is a serial interface slave with four possible IDs (0x90, 0x98, 0xB0 and 0xB8) determined by the S_CTRL_ADR0 and S_CTRL_ADR1 input pins. Data is transferred into the MT9V032 and out through the serial data (SDATA) line. The SDATA line is pulled up to VDD off-chip by a 1.5KΩ resistor. Either the slave or master device can pull the SDATA line down—the serial interface protocol determines which device is allowed to pull the SDATA line down at any given time. The registers are 16-bit wide, and can be accessed through 16- or 8-bit two-wire serial interface sequences.

Protocol

The two-wire serial interface defines several different transmission codes, as follows:

- a start bit
- the slave device 8-bit address
- a(n) (no) acknowledge bit
- an 8-bit message
- a stop bit

Sequence

A typical read or write sequence begins by the master sending a start bit. After the start bit, the master sends the slave device's 8-bit address. The last bit of the address determines if the request is a read or a write, where a "0" indicates a write and a "1" indicates a read. The slave device acknowledges its address by sending an acknowledge bit back to the master.

If the request was a write, the master then transfers the 8-bit register address to which a write should take place. The slave sends an acknowledge bit to indicate that the register address has been received. The master then transfers the data eight bits at a time, with the slave sending an acknowledge bit after each eight bits. The MT9V032 uses 16-bit data for its internal registers, thus requiring two 8-bit transfers to write to one register. After 16 bits are transferred, the register address is automatically incremented, so that the next 16 bits are written to the next register address. The master stops writing by sending a start or stop bit.

A typical read sequence is executed as follows. First the master sends the write mode slave address and 8-bit register address, just as in the write request. The master then sends a start bit and the read mode slave address. The master then clocks out the register data eight bits at a time. The master sends an acknowledge bit after each 8-bit transfer. The register address is auto-incremented after every 16 bits is transferred. The data transfer is stopped when the master sends a no-acknowledge bit. The MT9V032 allows for 8-bit data transfers through the two-wire serial interface by writing (or reading) the most significant 8 bits to the register and then writing (or reading) the least significant 8 bits to R0x80 (128).

Bus Idle State

The bus is idle when both the data and clock lines are HIGH. Control of the bus is initiated with a start bit, and the bus is released with a stop bit. Only the master can generate the start and stop bits.

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Start Bit

The start bit is defined as a HIGH-to-LOW transition of the data line while the clock line is HIGH.

Stop Bit

The stop bit is defined as a LOW-to-HIGH transition of the data line while the clock line is HIGH.

Slave Address

The 8-bit address of a two-wire serial interface device consists of 7 bits of address and 1 bit of direction. A "0" in the LSB of the address indicates write mode, and a "1" indicates read mode. As indicated above, the MT9V032 allows four possible slave addresses determined by the two input pins, S_CTRL_ADR0 and S_CTRL_ADR1.

Table 6: Slave Address Modes

{S_CTRL_ADR1, S_CTRL_ADR0}	Slave Address	Write/Read Mode
00	0x90	Write
	0x91	Read
01	0x98	Write
	0x99	Read
10	0xB0	Write
	0xB1	Read
11	0xB8	Write
	0xB9	Read

Data Bit Transfer

One data bit is transferred during each clock pulse. The two-wire serial interface clock pulse is provided by the master. The data must be stable during the HIGH period of the serial clock—it can only change when the two-wire serial interface clock is LOW. Data is transferred 8 bits at a time, followed by an acknowledge bit.

Acknowledge Bit

The master generates the acknowledge clock pulse. The transmitter (which is the master when writing, or the slave when reading) releases the data line, and the receiver indicates an acknowledge bit by pulling the data line LOW during the acknowledge clock pulse.

No-Acknowledge Bit

The no-acknowledge bit is generated when the data line is not pulled down by the receiver during the acknowledge clock pulse. A no-acknowledge bit is used to terminate a read sequence.

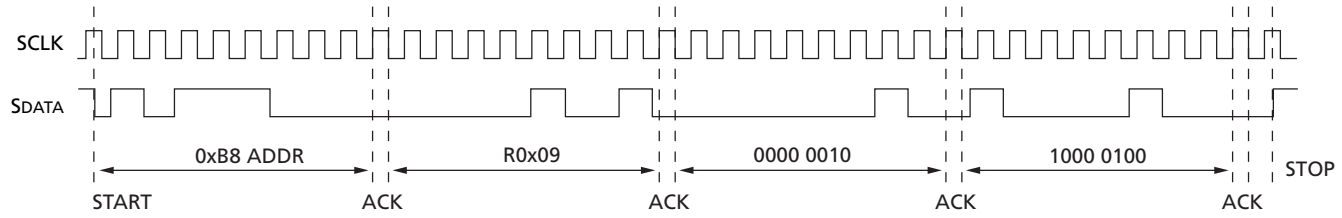
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Two-Wire Serial Interface Sample Read and Write Sequences

16-Bit Write Sequence

A typical write sequence for writing 16 bits to a register is shown in Figure 9. A start bit given by the master, followed by the write address, starts the sequence. The image sensor then gives an acknowledge bit and expects the register address to come first, followed by the 16-bit data. After each 8-bit the image sensor gives an acknowledge bit. All 16 bits must be written before the register is updated. After 16 bits are transferred, the register address is automatically incremented, so that the next 16 bits are written to the next register. The master stops writing by sending a start or stop bit.

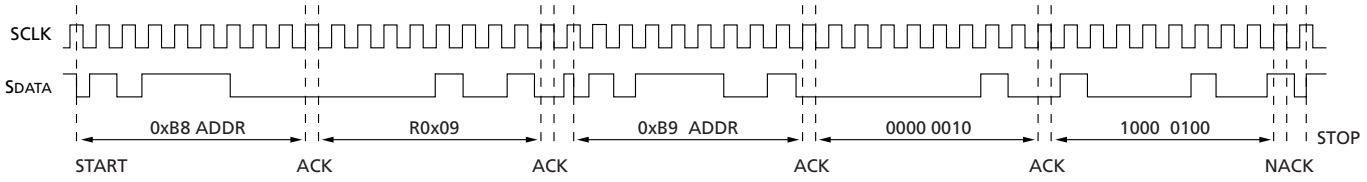
Figure 9: Timing Diagram Showing a Write to R0x09 with the Value 0x0284



16-Bit Read Sequence

A typical read sequence is shown in Figure 10. First the master has to write the register address, as in a write sequence. Then a start bit and the read address specifies that a read is about to happen from the register. The master then clocks out the register data 8 bits at a time. The master sends an acknowledge bit after each 8-bit transfer. The register address is auto-incremented after every 16 bits is transferred. The data transfer is stopped when the master sends a no-acknowledge bit.

Figure 10: Timing Diagram Showing a Read from R0x09; Returned Value 0x0284

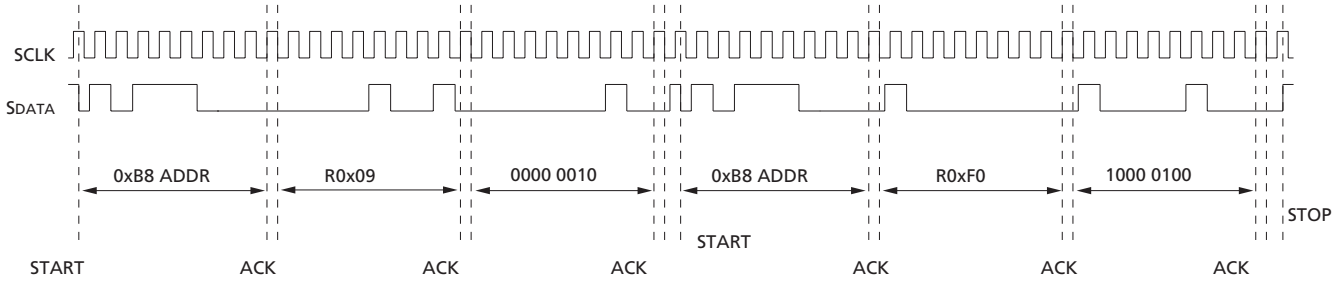


Eight-Bit Write Sequence

To be able to write one byte at a time to the register a special register address is added. The 8-bit write is done by first writing the upper 8 bits to the desired register and then writing the lower 8 bits to the special register address (R0xF1). The register is not updated until all 16 bits have been written. It is not possible to just update half of a register. In Figure 11 on page 12, a typical sequence for 8-bit writing is shown. The second byte is written to the special register (R0xF0).

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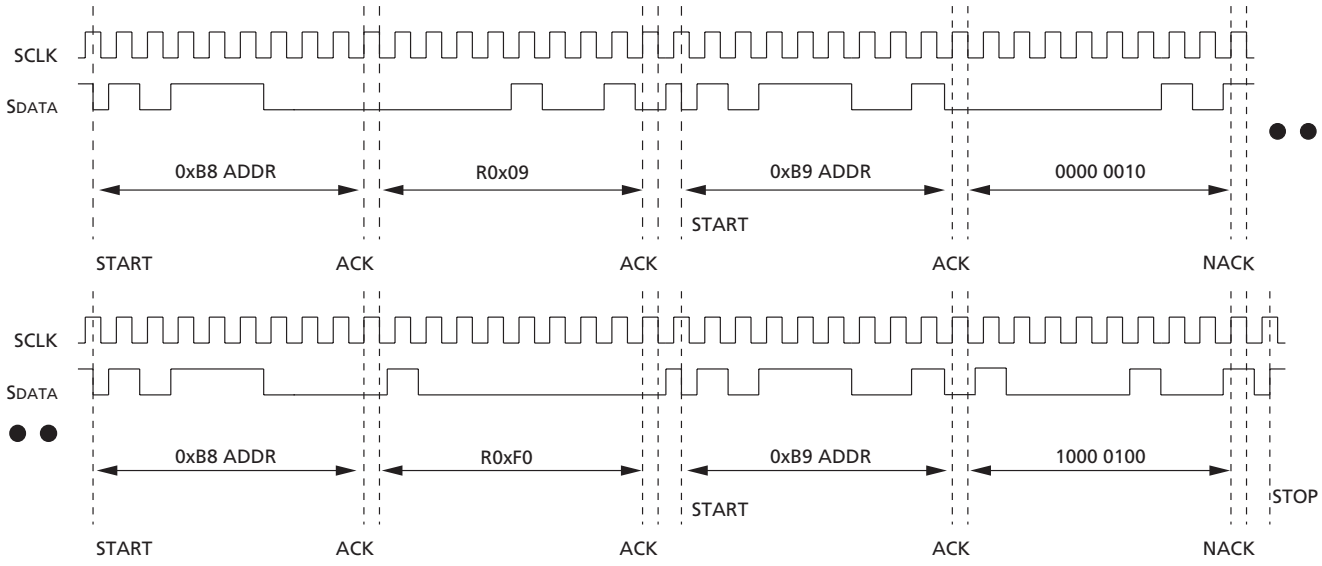
Figure 11: Timing Diagram Showing a Bytewise Write to R0x09 with the Value 0x0284



Eight-Bit Read Sequence

To read one byte at a time the same special register address is used for the lower byte. The upper 8 bits are read from the desired register. By following this with a read from the special register (R0xF1) the lower 8 bits are accessed (Figure 12). The master sets the no-acknowledge bits shown.

Figure 12: Timing Diagram Showing a Bytewise Read from R0x09; Returned Value 0x0284



Register Lock

R0xFE Register Lock

A register lock feature is included in the MT9V032 which may be used as a solution to reduce the probability of an inadvertent noise-triggered two-wire serial interface write to the sensor. All registers (or read mode register—register 13) only, can be locked; it is important to prevent an inadvertent two-wire serial interface write to register 13 in

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automotive applications since this register controls the image orientation and any unintended flip to an image can cause serious results.

At power-up, the register lock defaults to a value of 0xBEEF, which implies that all registers are unlocked and any two-wire serial interface writes to the register gets committed.

Lock All Registers

If a unique pattern (0xDEAD) to R0xFE is programmed, any subsequent two-wire serial interface writes to registers (except R0xFE) is NOT committed. Alternatively, if the user writes a 0xBEEF to the register lock register, all registers are unlocked and any subsequent two-wire serial interface writes to the register are committed.

Lock Read Mode Register Only (R0x0D)

If a unique pattern (0xDEAF) to R0xFE is programmed, any subsequent two-wire serial interface writes to register 13 is NOT committed. Alternatively, if the user writes a 0xBEEF to register lock register, register 13 is unlocked and any subsequent two-wire serial interface writes to this register is committed.

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Registers

Table 7: Default Register Descriptions

1 = always 1; 0 = always 0; d = programmable; ? = read only. Writing and changing the value of a reserved register (word or bit) puts the device in an unknown state and may damage the device.

Register # (Hex)	Description	Data Format (Binary)	Default Value (Hex)
0x00	Chip Version	0001 0011 0001 00001 (LSB)	Rev 1: 0x1311 Rev 2: 0x1311 Rev 3: 0x1313
0x01	Column Start	0000 00dd dddd dddd	0x0001
0x02	Row Start	0000 000d dddd dddd	0x0004
0x03	Window Height	0000 000d dddd dddd	0x01E0
0x04	Window Width	0000 00dd dddd dddd	0x02F0
0x05	Horizontal Blanking	0000 00dd dddd dddd	0x005E
0x06	Vertical Blanking	0ddd dddd dddd dddd	0x002D
0x07	Chip Control	0000 dddd dddd dddd	0x0388
0x08	Shutter Width 1	0ddd dddd dddd dddd	0x01BB
0x09	Shutter Width 2	0ddd dddd dddd dddd	0x01D9
0x0A	Shutter Width Ctrl	0000 00dd dddd dddd	0x0164
0x0B	Total Shutter Width	0ddd dddd dddd dddd	0x01E0
0x0C	Reset	0000 0000 0000 00dd	0x0000
0x0D	Read Mode	0000 0011 dddd dddd	0x0300
0x0E	Monitor Mode	0000 0000 0000 000d	0x0000
0x0F	Pixel Operation Mode	0000 0000 dddd dddd	0x0011
0x10	Reserved	–	0x0040
0x11	Reserved	–	0x8042
0x12	Reserved	–	0x0022
0x13	Reserved	–	0x2D32
0x14	Reservedl	–	0x0E02
0x15	Reserved	–	0x7F32
0x16	Reserved	–	0x2802
0x17	Reserved	–	0x3E38
0x18	Reserved	–	0x3E38
0x19	Reserved	–	0x2802
0x1A	Reserved	–	0x0428
0x1B	LED_OUT Ctrl	0000 0000 0000 00dd	0x0000
0x1C	ADC Mode Control	0000 0000 0000 00dd	0x0002
0x1D	Reserved	–	0x0000
0x1E	Reserved	–	0x0000
0x1F	Reserved	–	0x0000
0x20	Reserved	–	0x01D1
0x21	Reserved	–	0x0020
0x22	Reserved	–	0x0020
0x23	Reserved	–	0x0010

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Table 7: Default Register Descriptions (continued)

1 = always 1; 0 = always 0; d = programmable; ? = read only. Writing and changing the value of a reserved register (word or bit) puts the device in an unknown state and may damage the device.

Register # (Hex)	Description	Data Format (Binary)	Default Value (Hex)
0x24	Reserved	–	0x0010
0x25	Reserved	–	0x0020
0x26	Reserved	–	0x0010
0x27	Reserved	–	0x0010
0x28	Reserved	–	0x0010
0x29	Reserved	–	0x0010
0x2A	Reserved	–	0x0020
0x2B	Reserved	–	0x0004
0x2C	VREF_ADC Control	0000 0000 0000 0ddd	0x0840
0x2D	Reserved	–	0x0004
0x2E	Reserved	–	0x0007
0x2F	Reserved	–	0x0004
0x30	Reserved	–	0x0003
0x31	V1	0000 0000 000d dddd	0x001D
0x32	V2	0000 0000 000d dddd	0x0018
0x33	V3	0000 0000 000d dddd	0x0015
0x34	V4	0000 0000 000d dddd	0x0004
0x35	Analog Gain	0000 0000 0ddd dddd	0x0010
0x36	Max Analog Gain	0000 0000 0ddd dddd	0x0040
0x37	Reserved	–	0x0000
0x38	Reserved	–	0x0000
0x42	Frame Dark Average	0000 0000 ???? ????	RO
0x46	Dark Avg Thresholds	dddd dddd dddd dddd	0x231D
0x47	BL Calib Control	1000 0000 ddd0 000d	0x8080
0x48	BL Calibration Value	0000 0000 dddd dddd	0x0000
0x4C	BL Calib Step Size	0000 0000 000d dddd	0x0002
0x60	Reserved	–	0x0000
0x61	Reserved	–	0x0000
0x62	Reserved	–	0x0000
0x63	Reserved	–	0x0000
0x64	Reserved	–	0x0000
0x65	Reserved	–	0x0000
0x66	Reserved	–	0x0000
0x67	Reserved	–	0x0000
0x68	Reserved	–	RO
0x69	Reserved	–	RO
0x6A	Reserved	–	RO
0x6B	Reserved	–	RO

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Table 7: Default Register Descriptions (continued)

1 = always 1; 0 = always 0; d = programmable; ? = read only. Writing and changing the value of a reserved register (word or bit) puts the device in an unknown state and may damage the device.

Register # (Hex)	Description	Data Format (Binary)	Default Value (Hex)
0x6C	Reserved	–	0x0000
0x70	Row Noise Corr Ctrl 1	0000 d000 00d1 dddd	0x0034
0x71	Reserved	–	0x0000
0x72	Row Noise Constant	0000 0000 dddd dddd	0x002A
0x73	Row Noise Corr Ctrl 2	0000 00dd dddd dddd	0x02F7
0x74	Pixclk, FV, LV	0000 0000 000d dddd	0x0000
0x7F	Digital Test Pattern	0ddd ddd dddd dddd	0x0000
0x80	Tile Weight/Gain X0_Y0	0000 0000 dddd dddd	0x00F4
0x81	Tile Weight/Gain X1_Y0	0000 0000 dddd dddd	0x00F4
0x82	Tile Weight/Gain X2_Y0	0000 0000 dddd dddd	0x00F4
0x83	Tile Weight/Gain X3_Y0	0000 0000 dddd dddd	0x00F4
0x84	Tile Weight/Gain X4_Y0	0000 0000 dddd dddd	0x00F4
0x85	Tile Weight/Gain X0_Y1	0000 0000 dddd dddd	0x00F4
0x86	Tile Weight/Gain X1_Y1	0000 0000 dddd dddd	0x00F4
0x87	Tile Weight/Gain X2_Y1	0000 0000 dddd dddd	0x00F4
0x88	Tile Weight/Gain X3_Y1	0000 0000 dddd dddd	0x00F4
0x89	Tile Weight/Gain X4_Y1	0000 0000 dddd dddd	0x00F4
0x8A	Tile Weight/Gain X0_Y2	0000 0000 dddd dddd	0x00F4
0x8B	Tile Weight/Gain X1_Y2	0000 0000 dddd dddd	0x00F4
0x8C	Tile Weight/Gain X2_Y2	0000 0000 dddd dddd	0x00F4
0x8D	Tile Weight/Gain X3_Y2	0000 0000 dddd dddd	0x00F4
0x8E	Tile Weight/Gain X4_Y2	0000 0000 dddd dddd	0x00F4
0x8F	Tile Weight/Gain X0_Y3	0000 0000 dddd dddd	0x00F4
0x90	Tile Weight/Gain X1_Y3	0000 0000 dddd dddd	0x00F4
0x91	Tile Weight/Gain X2_Y3	0000 0000 dddd dddd	0x00F4
0x92	Tile Weight/Gain X3_Y3	0000 0000 dddd dddd	0x00F4
0x93	Tile Weight/Gain X4_Y3	0000 0000 dddd dddd	0x00F4
0x94	Tile Weight/Gain X0_Y4	0000 0000 dddd dddd	0x00F4
0x95	Tile Weight/Gain X1_Y4	0000 0000 dddd dddd	0x00F4
0x96	Tile Weight/Gain X2_Y4	0000 0000 dddd dddd	0x00F4
0x97	Tile Weight/Gain X3_Y4	0000 0000 dddd dddd	0x00F4
0x98	Tile Weight/Gain X4_Y4	0000 0000 dddd dddd	0x00F4
0x99	Tile Coord. X 0/5	0000 00dd dddd dddd	0x0000
0x9A	Tile Coord. X 1/5	0000 00dd dddd dddd	0x0096
0x9B	Tile Coord. X 2/5	0000 00dd dddd dddd	0x012C
0x9C	Tile Coord. X 3/5	0000 00dd dddd dddd	0x01C2
0x9D	Tile Coord. X 4/5	0000 00dd dddd dddd	0x0258
0x9E	Tile Coord. X 5/5	0000 00dd dddd dddd	0x02F0
0x9F	Tile Coord. Y 0/5	0000 000d dddd dddd	0x0000
0xA0	Tile Coord. Y 1/5	0000 000d dddd dddd	0x0060
0xA1	Tile Coord. Y 2/5	0000 000d dddd dddd	0x00C0
0xA2	Tile Coord. Y 3/5	0000 000d dddd dddd	0x0120
0xA3	Tile Coord. Y 4/5	0000 000d dddd dddd	0x0180

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Table 7: Default Register Descriptions (continued)

1 = always 1; 0 = always 0; d = programmable; ? = read only. Writing and changing the value of a reserved register (word or bit) puts the device in an unknown state and may damage the device.

Register # (Hex)	Description	Data Format (Binary)	Default Value (Hex)
0xA4	Tile Coord. Y 5/5	0000 000d dddd dddd	0x01E0
0XA5	AEC/AGC Desired Bin	0000 0000 00dd dddd	0x003A
0xA6	AEC Update Frequency	0000 0000 0000 dddd	0x0002
0xA7	Reserved	–	0x0000
0xA8	AEC LPF	0000 0000 0000 00dd	0x0000
0xA9	AGC Update Frequency	0000 0000 0000 dddd	0x0002
0xAA	Reserved	–	0x0000
0xAB	AGC LPF	0000 0000 0000 00dd	0x0002
0xAF	AEC/AGC Enable	0000 0000 0000 00dd	0x0003
0xB0	AEC/AGC Pix Count	dddd dddd dddd dddd	0xABE0
0xB1	LVDS Master Ctrl	0000 0000 0000 dddd	0x0002
0xB2	LVDS Shift Clk Ctrl	0000 0000 000d 0ddd	0x0010
0xB3	LVDS Data Ctrl	0000 0000 000d 0ddd	0x0010
0xB4	Data Stream Latency	0000 0000 0000 00dd	0x0000
0xB5	LVDS Internal Sync	0000 0000 0000 000d	0x0000
0xB6	LVDS Payload Control	0000 0000 0000 000d	0x0000
0xB7	Stereoscop. Error Ctrl	0000 0000 0000 0ddd	0x0000
0xB8	Stereoscop. Error Flag	0000 0000 0000 000?	RO
0xB9	LVDS Data Output	???? ???? ???? ????	RO
0xBA	AGC Gain Output	0000 0000 0??? ????	RO
0XBB	AEC Gain Output	???? ???? ???? ????	RO
0xBC	AGC/AEC Current Bin	0000 0000 00?? ????	RO
0xBD	Maximum Shutter Width	dddd dddd dddd dddd	0x01E0
0xBE	AGC/AEC Bin Difference Threshold	0000 0000 dddd dddd	0x0014
0xBF	Field Blank	0000 000d dddd dddd	0x0016
0xC0	Mon Mode Capture Ctrl	0000 0000 dddd dddd	0x000A
0xC1	Temperature	0000 00?? ???? ????	RO
0xC2	Analog Controls	dddd dddd dddd dddd	0x0840
0xC3	NTSC FV & LV Ctrl	0000 0000 0000 00dd	0x03840
0xC4	NTSC Horiz Blank Ctrl	dddd dddd dddd dddd	0x4416
0xC5	NTSC Vert Blank Ctrl	dddd dddd dddd dddd	0x4421
0xF0	Bytewise Addr	–	0x0000
0xF1	Reserved	–	Reserved
0xFE	Register Lock	dddd dddd dddd dddd	0xBEEF
0xFF	Chip Version	0001 0011 0000 0000	Rev 1: 0x1311 Rev 2: 0x1311 Rev 3: 0x1313

Table 8 on page 18 provides a detailed description of the registers. Bit fields that are not identified in the table are read only.

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Shadowed Registers

Some sensor settings cannot be changed during frame readout. For example, changing Window Width R0x04 part way through frame readout results in inconsistent LINE_VALID behavior. To avoid this, the MT9V032 double buffers many registers by implementing a "pending" and a "live" version. Two-wire serial interface reads and writes access the pending register. The live register controls the sensor operation. The value in the pending register is transferred to a live register at a fixed point in the frame timing, called "frame-start." Frame-start is defined as the point at which the first dark row is read out. By default, this occurs four row times before FRAME_VALID goes HIGH. To determine which registers or register fields are double-buffered in this way, see the "Shadowed" column in Table 8.

Table 8: Register Descriptions

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
0x00/0xFF (0/255) Chip Version						
15:0	Chip Version	Chip version—read-only	Rev 1: 0x1311 (4881) Rev 2: 0x1311 (4881) Rev 3: 0x1313 (4883)			R
0x01 (1) Column Start						
9:0	Column Start	The first column to be read out (not counting dark columns that may be read). To window the image down, set this register to the starting X value. Readable/active columns are 1–752.	1	Y	1–752	W
0x02 (2) Row Start						
8:0	Row Start	The first row to be read out (not counting any dark rows that may be read). To window the image down, set this register to the starting Y value. Setting a value less than four is not recommended since the dark rows should be read using R0x0D.	4	Y	4–482	W
0x03 (3) Window Height						
8:0	Window Height	Number of rows in the image to be read out (not counting any dark rows or border rows that may be read).	1E0 (480)	Y	1–480	W
0x04 (4) Window Width						
9:0	Window Width	Number of columns in image to be read out (not counting any dark columns or border columns that may be read).	2F0 (752)	Y	1–752	W
0x05 (5) Horizontal Blanking						
9:0	Horizontal Blanking	Number of blank columns in a row. Minimum horizontal blanking is 43 columns.	05E (94)	Y	43–1023	W
0x06 (6) Vertical Blanking						
14:0	Vertical Blanking	Number of blank rows in a frame. This number must be equal to or larger than four.	002D (45)	Y	4–3000	W

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
0x07 (7) Chip Control						
2:0	Scan Mode	0 = Progressive scan. 1 = Not valid. 2 = Two-field Interlaced scan. Even-numbered rows are read first, and followed by odd-numbered rows. 3 = Single-field Interlaced scan. If start address is even number, only even-numbered rows are read out; if start address is odd number, only odd-numbered rows are read out. Effective image size is decreased by half.	0	Y	0, 2, 3	W
3	Sensor Master/Slave Mode	0 = Slave mode. Initiating exposure and readout is allowed. 1 = Master mode. Sensor generates its own exposure and readout timing according to simultaneous/ sequential mode control bit.	1	Y	0,1	W
4	Sensor Snapshot Mode	0 = Snapshot disabled. 1 = Snapshot mode enabled. The start of frame is triggered by providing a pulse at EXPOSURE pin. Sensor master/slave mode should be set to logic 1 to turn on this mode.	0	Y	0,1	W
5	Stereoscopy Mode	0 = Stereoscopy disabled. Sensor is stand-alone and the PLL generates a 320 MHz (x12) clock. 1 = Stereoscopy enabled. The PLL generates a 480 MHz (x18) clock.	0	Y	0,1	W
6	Stereoscopic Master/Slave mode	0 = Stereoscopic master. 1 = Stereoscopic slave. Stereoscopy mode should be enabled when using this bit.	0	Y	0,1	W
7	Parallel Output Enable	0 = Disable parallel output. DOUT(9:0) are in High-Z. 1= Enable parallel output.	1	Y	0,1	W
8	Simultaneous/ Sequential Mode	0 = Sequential mode. Pixel and column readout takes place only after exposure is complete. 1 = Simultaneous mode. Pixel and column readout takes place in conjunction with exposure.	1	Y	0,1	W
0x08 (8) Shutter Width 1						
14:0	Shutter Width 1	The row number in which the first knee occurs. This may be used only when high dynamic range option (bit 6 of R0x0F) is enabled and exposure knee point auto adjust control bit is disabled. This register is not shadowed, but any change made does not take effect until the following new frame.	1BB (443)	N	1–480	W

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
0x09 (9) Shutter Width 2						
14:0	Shutter Width 2	The row number in which the second knee occurs. This may be used only when high dynamic range option (bit 6 of R0x0F) is enabled and exposure knee point auto adjust control bit is disabled. This register is not shadowed, but any change made does not take effect until the following new frame. Shutter width 2 = (bits 14:0) Note: t_1 = Shutter width 1; t_2 = Shutter width 2 – Shutter 1; t_3 = Total integration – Shutter width 2.	1D9 (473)	N	1–480	W
0x0A (10) Shutter Width Control						
3:0	T2 Ratio	One-half to the power of this value indicates the ratio of duration time t_2, when saturation control gate is adjusted to level V2 to total integration when exposure knee point auto adjust control bit is enabled. This register is not shadowed, but any change made does not take effect until the following new frame. t_2 = Total integration × $(½)^{t2_ratio}$.	4	N	0–15	W
7:4	T3 Ratio	One-half to the power of this value indicates the ratio of duration time t_3, when saturation control gate is adjusted to level V3 to total integration when exposure knee point auto adjust control bit is enabled. This register is not shadowed, but any change made does not take effect until the following new frame. t_3 = Total integration × $(½)^{t3_ratio}$. Note: t_1 = Total integration - t_2 - t_3.	6	N	0–15	W
8	Exposure Knee Point Auto Adjust Enable	0 = Auto adjust disabled. 1 = Auto adjust enabled.	1	N	0,1	W
9	Single Knee Enable	0 = Single knee disabled. 1 = Single knee enabled.	0	N	0,1	W
0x0B (11) Total Shutter Width						
14:0	Total Shutter Width	Total integration time in number of rows. This value is used only when AEC is disabled only (bit 0 of Register 175). This register is not shadowed, but any change made does not take effect until the following new frame.	1E0 (480)	N	1–480	W
0x0C (12) Reset						
0	Soft Reset	Setting this bit causes the sensor to abandon the current frame by resetting all digital logic except two-wire serial interface configuration. This is a self-resetting register bit and should always read “0.” (This bit de-asserts internal active LOW reset signal for 15 clock cycles.)	0	N	0, 1	W

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
1	Auto Block Soft Reset	Setting this bit causes the sensor to reset the automatic gain and exposure control logic. This is a self-resetting register bit and should always read "0." (This bit de-asserts internal active LOW reset signal for 15 clock cycles.)	0	Y	0, 1	W
0x0D (13) Read Mode						
1:0	Row Bin	0 = Normal operation. 1 = Row bin 2. Two pixel rows are read per row output. Image size is effectively reduced by a factor of 2 vertically while data rate and pixel clock are not affected. Resulting frame rate is increased by 2. 2 = Row bin 4. Four pixel rows are read per row output. Image size is effectively reduced by a factor of 4 vertically while data rate and pixel clock are not affected. Resulting frame rate is increased by 4. 3 = Not valid.	0	Y	0, 1, 2	W
3:2	Column Bin	0 = Normal operation. 1 = Column bin 2. When set, image size is reduced by a factor of 2 horizontally. Frame rate is not affected but data rate and pixel clock are reduced by one-half that of master clock. 2 = Column bin 4. When set, image size is reduced by a factor of 4 horizontally. Frame rate is not affected but data rate and pixel clock are reduced by one-fourth that of master clock. 3 = Not valid.	0	Y	0, 1, 2	W
4	Row Flip	Read out rows from bottom to top (upside down). When set, row readout starts from row (Row Start + Window Height) and continues down to (Row Start + 1). When clear, readout starts at Row Start and continues to (Row Start + Window Height - 1). This ensures that the starting color is maintained.	0	Y	0, 1	W
5	Column Flip	Read out columns from right to left (mirrored). When set, column readout starts from column (Col Start + Window Width) and continues down to (Col Start + 1). When clear, readout starts at Col Start and continues to (Col Start + Window Width - 1). This ensures that the starting color is maintained.	0	Y	0, 1	W
6	Show Dark Rows	When set, the programmed dark rows is output before the active window. Frame valid is thus asserted earlier than normal. This has no effect on integration time or frame rate. Whether the dark rows are shown in the image or not the definition frame start is before the dark rows are read out.	0	Y	0, 1	W
7	Show Dark Columns	When set, the programmed dark columns are output before the active pixels in a line. Line valid is thus asserted earlier than normal, and the horizontal blank time gets shorter by 18 pixel clocks.	0	Y	0, 1	W
9:8	Reserved	Reserved.	3			

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
0x0E (14) Monitor Mode						
0	Monitor Mode Enable	Setting this bit puts the sensor into a cycle of sleeping for five minutes, and waking up to capture a programmable number of frames (R0xC0). Clearing this bit resumes normal operation.	0	Y	0, 1	W
0x0F (15) Pixel Operation Mode						
2	Color/Mono	Should be set according to sensor type: 0 = Monochrome. 1 = Color.	0	Y	0, 1	W
6	High Dynamic Range	0 = Linear operation. 1 = High Dynamic Range. Voltage and shutter width must be correctly set for saturation control to operate.	0	Y	0, 1	W
0x1B (27) LED_OUT Control						
0	Disable LED_OUT	Disable LED_OUT output. When cleared, the output pin LED_OUT is pulsed high when the sensor is undergoing exposure.	0	Y	0, 1	W
1	Invert LED_OUT	Invert polarity of LED_OUT output. When set, the output pin LED_OUT is pulsed low when the sensor is undergoing exposure.	0	Y	0, 1	W
0x1C (28) ADC Resolution Control						
1:0	ADC Mode	0 = Invalid. 1 = Invalid. 2 = 10-bit linear. 3 = 12-to-10-bit companding.	2	Y	2, 3	W
0x2C (44) VREF_ADC Control						
2:0	VREF_ADC Voltage Level	0 = VREF_ADC = 1.0V. 1 = VREF_ADC = 1.1V. 2 = VREF_ADC = 1.2V. 3 = VREF_ADC = 1.3V. 4 = VREF_ADC = 1.4V. 5 = VREF_ADC = 1.5V. 6 = VREF_ADC = 1.6V. 7 = VREF_ADC = 2.1V. Range: 1.0–2.1V; Default: 1.4V VREF_ADC for ADC.	4	N	0–7	W
0x31 (49) V1 Control						
4:0	V1 voltage level	V_Step = bits (4:0) x 62.5mV + 0.5625V. Range: 0.5625 - 2.5V; Default: 2.375V. Usage: V_Step1 HiDy voltage.	1D (29)	N	0–31	W
0x32 (50) V2 Control						
4:0	V2 voltage level	V_Step = bits (4:0) x 62.5mV + 0.5625V. Range: 0.5625 - 2.5V; Default: 2.0625V. Usage: V_Step2 HiDy voltage.	18 (24)	N	0–31	W
0x33 (51) V3 Control						
4:0	V3 voltage level	V_Step = bits (4:0) x 62.5mV + 0.5625V. Range: 0.5625 - 2.5V; Default: 1.875V. Usage: V_Step3 HiDy voltage.	15 (21)	N	0–31	W

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
0x34 (52) V4 Control						
4:0	V4 voltage level	V_Step = bits (4:0) x 62.5mV + 0.5625V. Range: 0.5625 - 2.5V; Default: 0.8125V. Usage: V_Step HiDy parking voltage, also provides anti-blooming when V_Step is disabled.	4	N	0–31	W
0x35 (53) Analog Gain						
6:0	Analog Gain	Analog gain = bits (6:0) x 0.0625 for values 16–31: Analog gain = bits (6:0)/2 x 0.125 for values 32–64 For values 16–31: each LSB increases analog gain 0.0625v/v. A value of 16 = 1X gain. Range: 1X to 1.9375X. For values 32–64: each 2 LSB increases analog gain 0.125v/v. Range: 2X to 4X. An LSB increase of 1 will not increase the gain; the value must be incremented by 2. No exception detection is installed and caution should be taken when programming.	10 (16)	Y	16–64	W
0x36 (54) Maximum Analog Gain						
6:0	Maximum Analog Gain	This register is used by the automatic gain control (AGC) as the upper threshold of gain. This ensures the new calibrated gain value does not exceed that which the MT9V032 supports. Range: 16_{dec}–64_{dec} for 1X–4X respectively. Note: No exception detection is installed; caution should be taken when programming.	40 (64)	Y	16–64	W
0x42 (66) Frame Dark Average						
7:0	Frame Dark Average	The value read is the frame averaged black level, that is, used in the black level algorithm calculations.	0			R
0x46 (70) Dark Average Thresholds						
7:0	Lower threshold	Lower threshold for targeted black level in ADC LSBs.	1D (29)	N	0–255	W
15:8	Upper threshold	Upper threshold for targeted black level in ADC LSBs.	23 (35)	N	0–255	W
0x47 (71) Black Level Calibration Control						
0	Manual Override	Manual override of black level correction. 1 = Override automatic black level correction with programmed values. (R0x48). 0 = Normal operation (default).	0	N	0, 1	W
7:5	Frames to average over	Two to the power of this value decide how many frames to average over when the black level algorithm is in the averaging mode. In this mode the running frame average is calculated from the following formula: Running frame ave = Old running frame ave - (old running frame ave)/2n + (new frame ave)/ 2n.	4	N	0–7	W
15:8	Reserved	Reserved.	80 (128)			

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
0x48 (72) Black Level Calibration Value						
7:0	Black Level Calibration Value	Analog calibration offset: Negative numbers are represented with two's complement, which is shown in the following formula: Sign = bit 7 (0 is positive, 1 is negative). If positive offset value: Magnitude = bit 6:0. If negative offset value: Magnitude = not (bit 6:0) + 1. During two-wire serial interface read, this register returns the user-programmed value when manual override is enabled (R0x47 bit 0); otherwise, this register returns the result obtained from the calibration algorithm.	0	N	(-127) to 127	W
0x4C (76) Black Level Calibration Value Step Size						
4:0	Step Size of Calibration Value	This is the size calibration value may change (positively or negatively) from frame to frame. 1 calib LSB = ½ ADC LSB, assuming analog gain = 1.	2	N	0–31	W
0x70 (112) Row Noise Correction Control 1						
3:0	Number of Dark Pixels	The number of pixels used in the row-wise noise calculation. 0 = 2 pixels. 1 = 4 pixels. 2 = 6 pixels. 4 = 10 pixels. 8 = 18 pixels. See "Row-wise Noise Correction" on page 41 for additional information.	4	Y	0, 1, 2, 4, 8	W
4	Reserved	Reserved.	1			
5	Enable noise correction	0 = Normal operation. 1 = Enable row noise cancellation algorithm. When this bit is set, on a per row basis, the dark average is subtracted from each pixel in the row, and then a constant (R0x72) is added.	1	Y	0, 1	W
11	Use black level average	1 = Use black level frame average from the dark rows in the row noise correction algorithm for low gains. This frame average was taken before the last adjustment of the offset DAC for that frame, so it might be slightly off. 0 = Use the average value of the dark columns read out in each row as dark average.	0	Y	0, 1	W
0x72 (114) Row Noise Constant						
7:0	Row noise constant	Constant used in the row noise cancellation algorithm. It should be set to the dark level targeted by the black level algorithm plus the noise expected between the averaged values of dark columns. At default the constant is set to 42 LSB.	2A (42)	Y	0–255	W
0x73 (115) Row Noise Correction Control 2						
9:0	Dark start column address	The starting column address for the dark columns to be used in the row-wise noise correction algorithm.	2F7 (759)	Y	759–775	W

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
0x74 (116) Pixel Clock, FRAME and LINE VALID Control						
0	Invert Line Valid	Invert line valid. When set, LINE_VALID is reset to logic "0" when DOUT is valid.	0	Y	0, 1	W
1	Invert Frame Valid	Invert frame valid. When set, FRAME_VALID is reset to logic "0" when frame is valid.	0	Y	0, 1	W
2	XOR Line Valid	1 = Line valid = "Continuous" Line Valid XOR Frame Valid 0 = Line Valid determined by bit 3. Ineffective if Continuous Line Valid is set.	0	Y	0, 1	W
3	Continuous Line Valid	1 = "Continuous" Line Valid (continue producing line valid during vertical blank). 0 = Normal Line Valid (default, no line valid during vertical blank).	0	Y	0, 1	W
4	Invert Pixel Clock	Invert pixel clock. When set, LINE_VALID, FRAME_VALID, and DOUT is set up to the rising edge of pixel clock, PIXCLK. When clear, they are set up to the falling edge of PIXCLK.	0	Y	0, 1	W
0x7F (127) Digital Test Pattern						
9:0	Two-wire Serial Interface Test Data	The 10-bit test data in this register is used in place of the data from the sensor. The data is inserted at the beginning of the digital signal processing. Both test enable (bit 13) and use two-wire serial interface (bit 10) must be set.	0	N	0–1023	W
10	Use Two-wire Serial Interface Test Data	0 = Use Gray Shade Test Pattern as test data. 1 = Use Two-wire Serial Interface Test Data (bits 9:0) as test data.	0	N	0, 1	W
12:11	Gray Shade Test Pattern	0 = None. 1 = Vertical Shades. 2 = Horizontal Shades. 3 = Diagonal Shade. When bits (12:11) ≠ 0, the MT9V032 generates a gray shaded test pattern to be used as digital test data. Ineffective when Use Two-wire Serial Interface Test Data (bit 10) is set.	0	N	0–3	W
13	Test Enable	Enable the use of test data/gray shaded test pattern in the signal chain. The data is inserted instead of data from the ADCs. Set R0x70 bit 5 = 0 when using this mode. If R0x70 bit 5 = 1, the row-wise correction algorithm processes the test data values and the result is not accurate.	0	Y	0, 1	W
14	Flip Two-Wire Serial Interface Test Data	Use only when two-wire serial interface test data (bit 10) is set. When set, the two-wire serial interface test data (bits 9:0) is used in place of the data from ADC/memory on odd columns, while complement of the two-wire serial interface test data is used on even columns.	0	N	0, 1	W
0x80 (128) - 0x98 (152) Tiled Digital Gain						

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
3:0	Tile Gain	Tile Digital Gain = Bits (3:0) x 0.25. See "Gain Settings" on page 38 for additional information on digital gain.	4	Y	1–15	W
7:4	Sample Weight	To indicate the weight of individual tile used in the automatic gain/exposure control algorithm.	F (15)	Y	0–15	W
Refer to Figure 25 on page 40 for R0x99 (153) - R0xA4 (164).						
0x99 (153) Digital Tile Coordinate 1 - X-direction						
9:0	$X_{0/5}$	The starting x-coordinate of digital tiles X0_*.	0	Y	0–752	W
0x9A (154) Digital Tile Coordinate 2 - X-direction						
9:0	$X_{1/5}$	The starting x-coordinate of digital tiles X1_*.	096 (150)	Y	0–752	W
0x9B (155) Digital Tile Coordinate 3 - X-direction						
9:0	$X_{2/5}$	The starting x-coordinate of digital tiles X2_*.	12C (300)	Y	0–752	W
0x9C (156) Digital Tile Coordinate 4 - X-direction						
9:0	$X_{3/5}$	The starting x-coordinate of digital tiles X3_*.	1C2 (450)	Y	0–752	W
0x9D (157) Digital Tile Coordinate 5 - X-direction						
9:0	$X_{4/5}$	The starting x-coordinate of digital tiles X4_*.	258 (600)	Y	0–752	W
0x9E (158) Digital Tile Coordinate 6 - X-direction						
9:0	$X_{5/5}$	The ending x-coordinate of digital tiles X4_*.	2F0 (752)	Y	0–752	W
0x9F (159) Digital Tile Coordinate 1 - Y-direction						
8:0	$Y_{0/5}$	The starting y-coordinate of digital tiles *_Y0.	0	Y	0–480	W
0xA0 (160) Digital Tile Coordinate 2 - Y-direction						
8:0	$Y_{1/5}$	The starting y-coordinate of digital tiles *_Y1.	60 (96)	Y	0–480	W
0xA1 (161) Digital Tile Coordinate 3 - Y-direction						
8:0	$Y_{2/5}$	The starting y-coordinate of digital tiles *_Y2.	0C0 (192)	Y	0–480	W
0xA2 (162) Digital Tile Coordinate 4 - Y-direction						
8:0	$Y_{3/5}$	The starting y-coordinate of digital tiles *_Y3.	120 (288)	Y	0–480	W
0xA3 (163) Digital Tile Coordinate 5 - Y-direction						
8:0	$Y_{4/5}$	The starting y-coordinate of digital tiles *_Y4.	180 (384)	Y	0–480	W
0xA4 (164) Digital Tile Coordinate 6 - Y-direction						
8:0	$Y_{5/5}$	The ending y-coordinate of digital tiles *_Y4.	1E0 (480)	Y	0–480	W
0xA5 (165) AEC/AGC Desired Bin						
5:0	Desired Bin	User-defined "desired bin" that gives a measure of how bright the image is intended.	3A (58)	Y	1–64	W
0xA6 (166) AEC Update Frequency						
3:0	Exp Skip Frame	The number of frames that the AEC must skip before updating the exposure register (R0xBB).	2	Y	0–15	W

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
0xA8 (168) AEC Low Pass Filter						
1:0	Exp LPF	This value plays a role in determining the increment/ decrement size of exposure value from frame to frame. If current bin ≠ 0 (R0xBC), When Exp LPF = 0: Actual new exposure = Calculated new exposure When Exp LPF = 1: If |(Calculated new exp - current exp) | > (current exp/4), Actual new exposure = Calculated new exposure, otherwise Actual new exposure = Current exp ± (calculated new exp/2) When Exp LPF = 2: If |(Calculated new exp - current exp) |> (current exp/4), Actual new exposure = Calculated new exposure, otherwise Actual new exposure = Current exp ± (calculated new exp/4)	2	Y	0–2	WX
0xA9 (169) AGC Output Update Frequency						
3:0	Gain Skip Frame	The number of frames that the AGC must skip before updating the gain register (R0xBA).	2	Y	0–15	W
0xAB (171) AGC Low Pass Filter						
1:0	Gain LPF	This value plays a role in determining the increment/ decrement size of gain value from frame to frame. If current bin ≠ 0 (R0xBC) When Gain LPF = 0: Actual new gain = Calculated new gain When Exp LPF = 1: if |(Calculated new gain - current gain) | > (current gain/4), Actual new gain = Calculated new gain, otherwise Actual new gain = Current exp ± (calculated new gain/2) When Exp LPF = 2: if |(Calculated new gain - current gain) | > (current gain /4), Actual new gain = Calculated new gain, otherwise Actual new gain = Current gain ± (calculated new gain/4).	2	Y	0–2	W
0xAF (175) AGC/AEC Enable						
0	AEC Enable	0 = Disable Automatic Exposure Control. 1 = Enable Automatic Exposure Control.	1	Y	0, 1	W
1	AGC Enable	0 = Disable Automatic Gain Control. 1 = Enable Automatic Gain Control.	1	Y	0, 1	W
0xB0 (176) AGC/AEC Pixel Count						

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
15-0	Pixel Count	The number of pixel used for the AEC/AGC histogram.	ABE0 (44,000)	Y	0–65535	W
0xB1 (177) LVDS Master Control						
0	PLL Bypass	0 = Internal shift-CLK is driven by PLL. 1 = Internal shift-CLK is sourced from the LVDS_BYPASS_CLK.	0	Y	0, 1	W
1	LVDS Power-down	0 = Normal operation. 1 = Power-down LVDS block.	1	Y	0, 1	W
2	PLL Test Mode	0 = Normal operation. 1 = The PLL output frequency is equal to the system clock frequency (26.6 MHz).	0	Y	0, 1	W
3	LVDS Test Mode	0 = Normal operation. 1 = The SER_DATAOUT_P drives a square wave in both stereo and stand-alone modes). In stereo mode, ensure that SER_DATAIN_P is logic “0.”	0	Y	0, 1	W
0xB2 (178) LVDS Shift Clock Control						
2:0	Shift-clk Delay Element Select	The amount of shift-CLK delay that minimizes inter-sensor skew.	0	Y	0–7	W
4	LVDS Receiver Power-down	When set, LVDS receiver is disabled.	1	Y	0, 1	W
0xB3 (179) LVDS Data Control						
2:0	Data Delay Element Select	The amount of data delay that minimizes inter-sensor skew.	0	Y	0–7	W
4	LVDS Driver Power-down	When set, LVDS driver is disabled.	1	Y	0, 1	W
0xB4 (180) LVDS Latency						
1:0	Stream Latency Select	The amount of delay so that the two streams are in sync.	0	Y	0–3	W
0xB5 (181) LVDS Internal Sync						
0	LVDS Internal Sync Enable	When set, the MT9V032 generates sync pattern (data with all zeros except start bit) on LVDS_SER_DATA_OUT.	0	Y	0, 1	W
0xB6 (182) LVDS Payload Control						
0	Use 10-bit Pixel Enable	When set, all 10 pixel data bits are output in stand-alone mode. Control signals are embedded. If clear, 8 bits of pixel data are output with 2 control bits. See “LVDS Output Format” on page 48 for additional information.	0	Y	0, 1	W
0xB7 (183) Stereoscopy Error Control						
0	Enable Stereo Error Detect	Set this bit to enable stereo error detect mechanism.	0	Y	0, 1	W
1	Enable Stick Stereo Error Flag	When set, the stereo error flag remains asserted once an error is detected unless clear stereo error flag (bit 2) is set.	0	Y	0, 1	W
2	Clear Stereo Error Flag	Set this bit to clear the stereoscopy error flag (R0xB8 returns to logic 0).	0	Y	0, 1	W

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
0xB8 (184) Stereoscopy Error Flag						
0	Stereoscopy Error Flag	Stereoscopy error status flag. It is also directly connected to the ERROR output pin.				R
0xB9 (185) LVDS Data Output						
15:0	Combo Reg	This 16-bit value contains both 8-bit pixel values from both stereoscopic master and slave sensors. It can be used in diagnosis to determine how well in sync the two sensors are. Captures the state when master sensor has issued a reserved byte and slave has not. Note: This register should be read from the stereoscopic master sensor only.				R
0xBA (186) AGC Gain Output						
6:0	AGC Gain	Status register to report the current gain value obtained from the AGC algorithm.	10 (16)			R
0xBB (187) AEC Exposure Output						
15:0	AEC Exposure	Status register to report the current exposure value obtained from the AEC Algorithm.	00C8 (200)			R
0xBC (188) AGC/AEC Current Bin						
5:0	Current Bin	Status register to report the current bin of the histogram.				R
0xBD (189) Maximum Total Shutter Width						
15:0	Maximum Total Shutter Width	This register is used by the automatic exposure control (AEC) as the upper threshold of exposure. This ensures the new calibrated integration value does not exceed that which the MT9V032 supports.	01E0 (480)	Y	1–2047	W
0xBE (190) AGC/AEC Bin Difference Threshold						
7:0	Bin Difference Threshold	This register is used by the AEC only when exposure reaches its minimum value of 1. If the difference between desired bin (R0xA5) and current bin (R0xBC) is larger than the threshold, the exposure is increased.	14 (20)	Y	0–63	W
0xBF (191) Field Vertical Blank						
8:0	Field Vertical Blank	The number of blank rows between odd and even fields. Note: For interlaced (both field) mode only. See R0x07[2:0].	16 (22)	Y	0–255	W
0xC0 (192) Monitor Mode Capture Control						
7:0	Image Capture Numb	The number of frames to be captured during the wake-up period when monitor mode is enabled.	0A (10)	Y	0–255	W
0xC1 (193) Thermal Information						
9:0	Temperature Output	Status register to report the temperature of sensor. Updated once per frame.				R
0xC2 (194) Analog Controls						
6	Reserved	Reserved.	1	N	0, 1	W
7	Anti-Eclipse Enable	Setting this bit turns on anti-eclipse circuitry.	0	N	0, 1	W

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Table 8: Register Descriptions (continued)

Bit	Bit Name	Bit Description	Default in Hex (dec)	Shadowed	Legal Values (dec)	Read/ Write
11:13	V_rst_lim voltage Level	V_rst_lim = bits (2:0) × 50mV + 1.95V Range: 1.95–2.30V; Default: 2.00V Usage: For anti-eclipse reference voltage control	1	N	0–7	W
0xC3 (195) NTSC Frame Valid Control						
0	Extend Frame Valid	When set, frame valid is extended for half-line in length at the odd field.	0	Y	0, 1	W
1	Replace FV/LV with Ped/Snyc	When set, frame valid and line valid is replaced by ped and sync signals respectively.	0	Y	0, 1	W
0xC4 (196) NTSC Horizontal Blanking Control						
7:0	Front porch width	The front porch width in number of master clock cycle. NTSC standard is 1.5µsec ±0.1µsec	16 (22)	Y	0–255	W
15:8	Sync Width	The sync pulse width in number of master clock cycle. NTSC standard is 4.7µsec ±0.1µsec.	044 (68)	Y	0–255	W
0xC5 (197) NTSC Vertical Blanking Control						
7:0	Equalizing Pulse Width	The pulse width in number of master clock cycle. NTSC standard is 2.3µsec ±0.1µsec.	21 (33)	Y	0–255	W
15:8	Vertical Serration Width	The pulse width in number of master clock cycle. NTSC standard is 4.7µsec ±0.1µsec.	44 (68)	Y	0–255	W
0xF0 (240) Bytewise Address						
	Bytewise Address	Special address to perform 8-bit READs and WRITEs to the sensor. See the "Two- Wire Serial Interface Sample Read and Write Sequen ces" on page 11” for further details on how to use this functionality.				
0xFE (254) Register Lock						
15:0	Register Lock Code	To lock all registers except R0xFE, program data with 0xDEAD; to unlock two-wire serial interface, program data with 0xBEEF. When two-wire serial interface is locked, any subsequent two-wire serial interface write to register other than to two-wire serial interface Protect Enable Register is ignored until two-wire serial interface is unlocked. To lock Register 13 only, program data with 0xDEAF; to unlock, program data with 0xBEEF. When Register 13 is locked, any subsequent two-wire serial interface write to this register only is ignored until register is unlocked.	BEEF (48879)	N	48879, 57005, 57007	W

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Feature Description

Operational Modes

The MT9V032 works in master, snapshot, or slave mode. In master mode the sensor generates the readout timing. In snapshot mode it accepts an external trigger to start integration, then generates the readout timing. In slave mode the sensor accepts both external integration and readout controls. The integration time is programmed through the two-wire serial interface during master or snapshot modes, or controlled via externally generated control signal during slave mode.

Master Mode

There are two possible operation methods for master mode: simultaneous and sequential. One of these operation modes must be selected via the two-wire serial interface.

Simultaneous Master Mode

In simultaneous master mode, the exposure period occurs during readout. The frame synchronization waveforms are shown in Figure 13 and Figure 14. The exposure and readout happen in parallel rather than sequential, making this the fastest mode of operation.

Figure 13: Simultaneous Master Mode Synchronization Waveforms #1

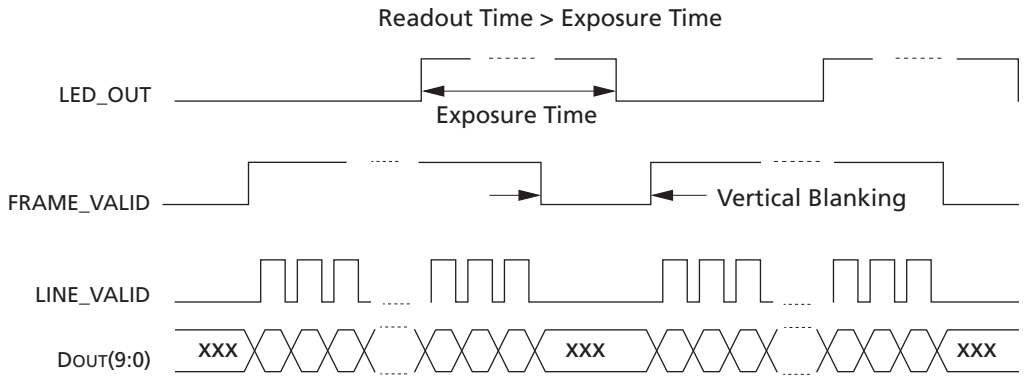
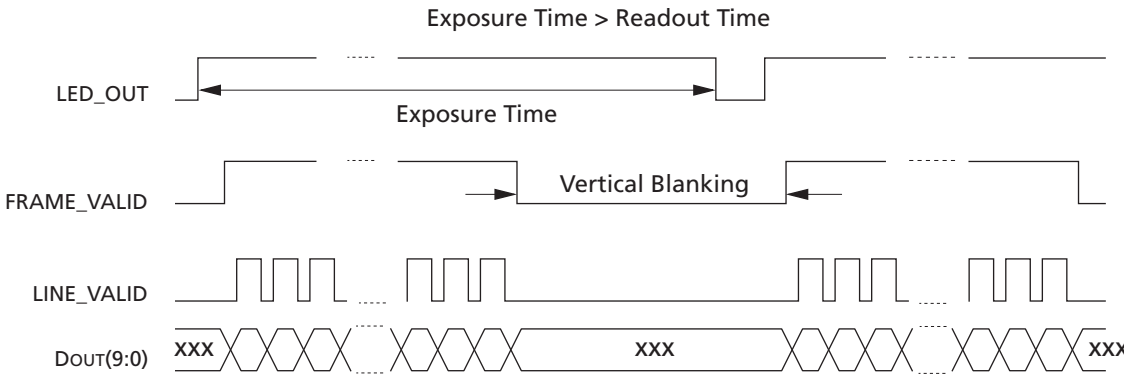


Figure 14: Simultaneous Master Mode Synchronization Waveforms #2



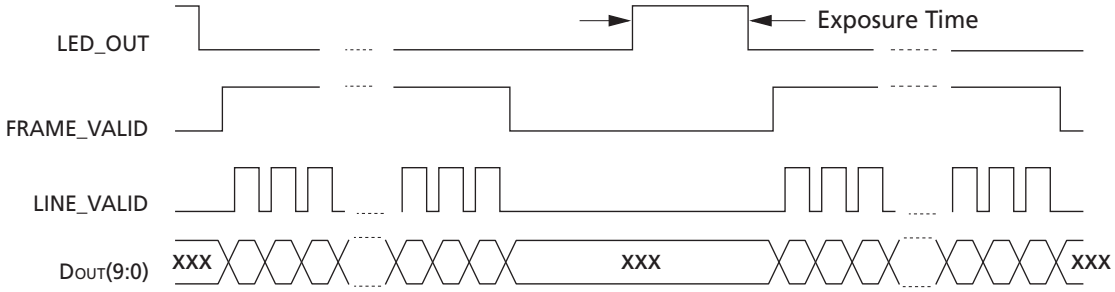
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When exposure time is greater than the sum of vertical blank and window height, the number of vertical blank rows is increased automatically to accommodate the exposure time.

Sequential Master Mode

In sequential master mode the exposure period is followed by readout. The frame synchronization waveforms for sequential master mode are shown in Figure 15. The frame rate changes as the integration time changes.

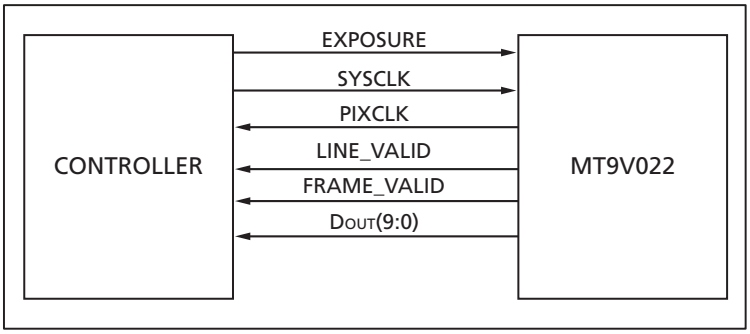
Figure 15: Sequential Master Mode Synchronization Waveforms



Snapshot Mode

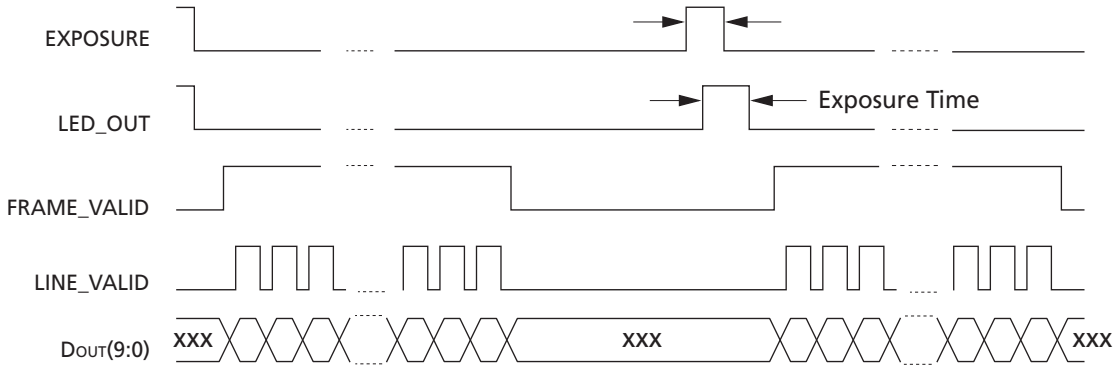
In snapshot mode the sensor accepts an input trigger signal which initiates exposure, and is immediately followed by readout. The interface signals utilized in snapshot mode are depicted in Figure 16. In snapshot mode, the start of the integration period is determined by the externally applied EXPOSURE pulse that is input to the MT9V032. The integration time is preprogrammed via the two-wire serial interface on R0x0B. After the frame's integration period is complete the readout process commences and the syncs and data are output. Sensor in snapshot mode can capture a single image or a sequence of images. The frame rate may only be controlled by changing the period of the user supplied EXPOSURE pulse train. The frame synchronization waveforms for snapshot mode are shown in Figure 17.

Figure 16: Snapshot Mode Interface Signals



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Figure 17: Snapshot Mode Frame Synchronization Waveforms



Slave Mode

In slave mode, the exposure and readout are controlled using the EXPOSURE, STFRM_OUT, and STLN_OUT pins. When the slave mode is enabled, STFRM_OUT and STLN_OUT become input pins.

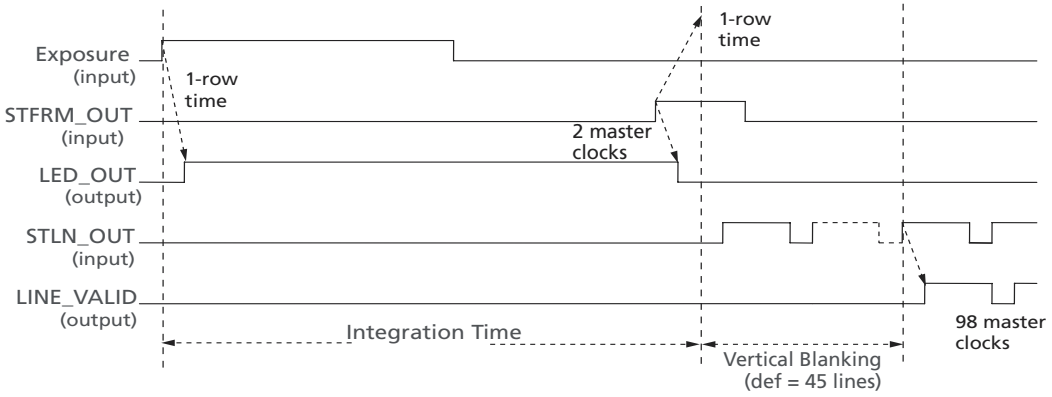
The start and end of integration are controlled by EXPOSURE and STFRM_OUT pulses, respectively. While a STFRM_OUT pulse is used to stop integration, it is also used to enable the readout process.

After integration is stopped, the user provides STLN_OUT pulses to trigger row readout. A full row of data is read out with each STLN_OUT pulse. The user must provide enough time between successive STLN_OUT pulses to allow the complete readout of one row.

It is also important to provide additional STLN_OUT pulses to allow the sensors to read the vertical blanking rows. It is recommended that the user program the vertical blank register (R0x06) with a value of 4, and achieve additional vertical blanking between frames by delaying the application of the STFRM_OUT pulse.

The elapsed time between the rising edge of STLN_OUT and the first valid pixel data is [horizontal blanking register (R0x05) + 4] clock cycles.

Figure 18: Slave Mode Operation

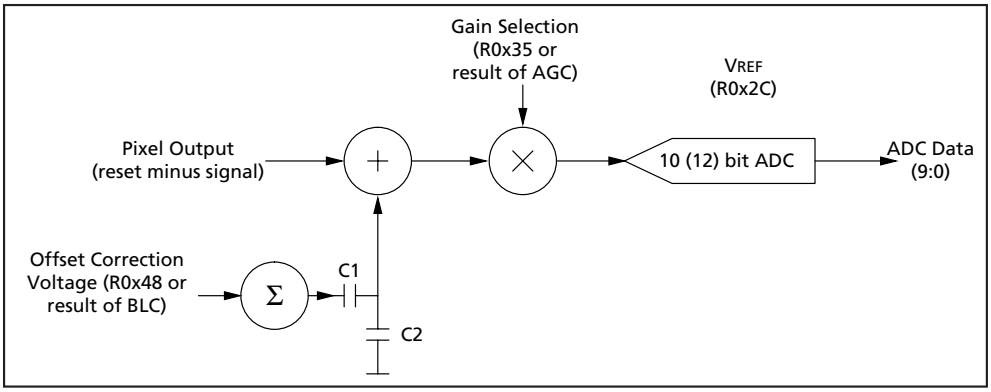


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Signal Path

The MT9V032 signal path consists of a programmable gain, a programmable analog offset, and a 10-bit ADC. See "Black Level Calibration" on page 40 for the programmable offset operation description.

Figure 19: Signal Path



On-Chip Biases

ADC Voltage Reference

The ADC voltage reference is programmed through R0x2C, bits 2:0. The ADC reference ranges from 1.0V to 2.1V. The default value is 1.4V. The increment size of the voltage reference is 0.1V from 1.0V to 1.6V (R0x2C[2:0] values 0 to 6). At R0x2C[2:0] = 7, the reference voltage jumps to 2.1V.

The effect of the ADC calibration does not scale with VREF. Instead it is a fixed value relative to the output of the analog gain stage. At default, one LSB of calibration equals two LSB in output data ($1LSB_{Offset}$ = 2mV, $1LSB_{ADC}$ = 1mV).

It is very important to preserve the correct values of the other bits in R0x2C. The default register setting is 0x0004.

V_Step Voltage Reference

This voltage is used for pixel high dynamic range operations, programmable from R0x31 through R0x34.

Chip Version

Chip version registers R0x00 and R0xFF are read-only.

Window Control

Registers R0x01 column start, R0x02 Row Start, R0x03 window height (row size), and R0x04 Window Width (column size) control the size and starting coordinates of the window.

The values programmed in the window height and width registers are the exact window height and width out of the sensor. The window start value should never be set below four.

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To read out the dark rows set bit 6 of R0x0D. In addition, bit 7 of R0x0D can be used to display the dark columns in the image.

Blanking Control

Horizontal blanking and vertical blanking registers R0x05 and R0x06 respectively control the blanking time in a row (horizontal blanking) and between frames (vertical blanking).

- Horizontal blanking is specified in terms of pixel clocks.
- Vertical blanking is specified in terms of numbers of rows.

The actual imager timing can be calculated using Table 4 on page 7 and Table 5 on page 8 which describe "Row Timing and FRAME_VALID/LINE_VALID signals." The minimum number of vertical blank rows is 4.

Pixel Integration Control

Total Integration

R0x0B Total Shutter Width (In Terms of Number of Rows)

This register (along with the window width and horizontal blanking registers) controls the integration time for the pixels.

The actual total integration time, ^{t}INT, is:

^{t}INT = (Number of rows of integration × row time) + Overhead, where:
The number of rows integration is equal to the result of automatic exposure control (AEC) which may vary from frame to frame, or, if AEC is disabled, the value in R0x0B
Row time = (R0x04 + R0x05) master clock periods
Overhead = (R0x04 + R0x05 – 255) master clock periods

Typically, the value of R0x0B (total shutter width) is limited to the number of rows per frame (which includes vertical blanking rows), such that the frame rate is not affected by the integration time. If R0x0B is increased beyond the total number of rows per frame, it is required to add additional blanking rows using R0x06 as needed. A second constraint is that ^{t}INT must be adjusted to avoid banding in the image from light flicker. Under 60Hz flicker, this means frame time must be a multiple of 1/120 of a second. Under 50Hz flicker, frame time must be a multiple of 1/100 of a second.

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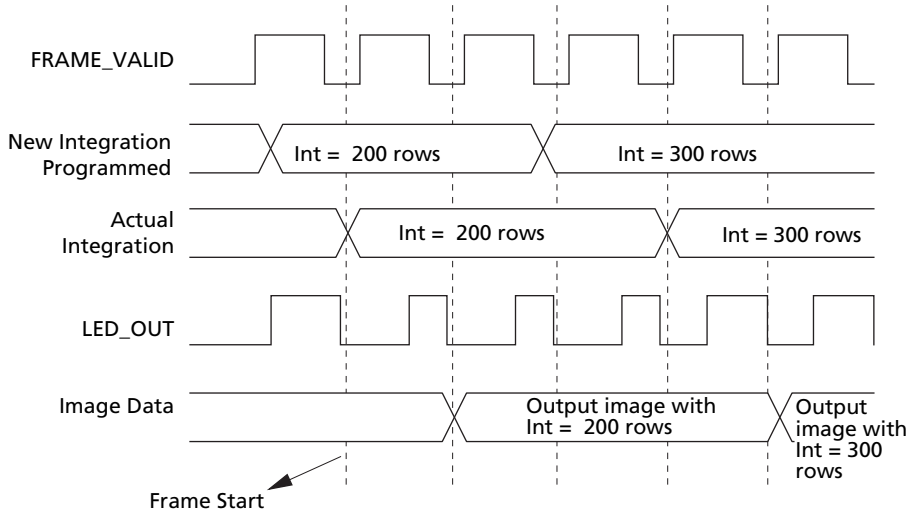
Changes to Integration Time

With automatic exposure control disabled (R0xAF, bit 0 is cleared to LOW), and if the total integration time (R0x0B) is changed via the two-wire serial interface while FRAME_VALID is asserted for frame *n*, the first frame output using the new integration time is frame (*n* + *2*). Similarly, when automatic exposure control is enabled, any change to the integration time for frame *n* first appears in frame (*n* + *2*) output.

The sequence is as follows:

4. During frame *n*, the new integration time is held in the R0x0B live register.
5. At the start of frame (*n* + *1*), the new integration time is transferred to the exposure control module. Integration for each row of frame (*n* + *1*) has been completed using the old integration time. The earliest time that a row can start integrating using the new integration time is immediately after that row has been read for frame (*n* + *1*). The actual time that rows start integrating using the new integration time is dependent on the new value of the integration time.
6. When frame (*n* + *1*) is read out, it is integrated using the new integration time. If the integration time is changed (R0x0B written) on successive frames, each value written is applied to a single frame; the latency between writing a value and it affecting the frame readout remains at two frames.
   However, when automatic exposure control is disabled, if the integration time is changed via the two-wire serial interface after the falling edge of FRAME_VALID for frame *n*, the first frame output using the new integration time becomes frame (*n* + *3*).

Figure 20: Latency When Changing Integration



Exposure Indicator

R0x1B LED_OUT Control

The MT9V032 provides an output pin, LED_OUT, to indicate when the exposure takes place. When R0x1B bit 0 is clear, LED_OUT is HIGH during exposure. By using R0x1B, bit 1, the polarity of the LED_OUT pin can be inverted.

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High Dynamic Range

R0x08 Shutter Width 1, R0x09 Shutter Width 2, R0x0A Shutter Width Control

R0x31–R0x34 V_Step Voltages

In the MT9V032, high dynamic range (that is, R0x0F, bit 6 = 1) is achieved by controlling the saturation level of the pixel (HDR or high dynamic range gate) during the exposure period. The sequence of the control voltages at the HDR gate is shown in Figure 21. After the pixels are reset, the step voltage, V_Step, which is applied to HDR gate, is setup at V1 for integration time t_1 then to V2 for time t_2, then V3 for time t_3, and finally it is parked at V4, which also serves as an antiblooming voltage for the photodetector. This sequence of voltages leads to a piece-wise linear pixel response, illustrated (in approximates) in Figure 21 on page 37.

Figure 21: Sequence of Control Voltages at the HDR Gate

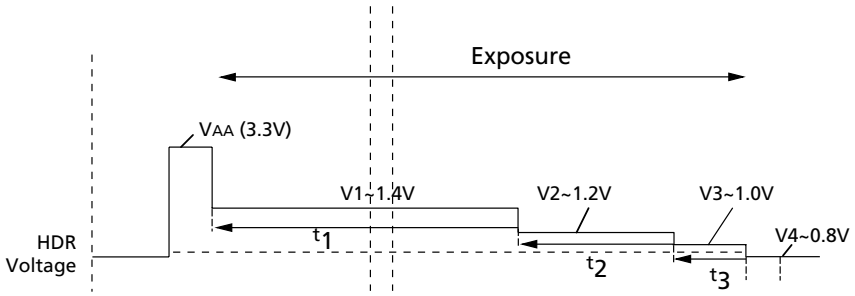
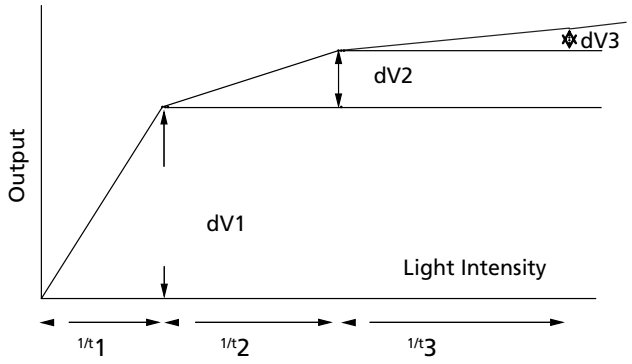


Figure 22: Sequence of Voltages in a Piecewise Linear Pixel Response



The parameters of the step voltage V_Step which takes values V1, V2, and V3 directly affect the position of the knee points in Figure 22.

Light intensities work approximately as a reciprocal of the partial exposure time. Typically $^{t}1$ is the longest exposure, $^{t}2$ shorter, and so on. Thus the range of light intensities is shortest for the first slope, providing the highest sensitivity.

Register settings for V_Step and partial exposures:

V1 = R0x31, bits 4:0
V2 = R0x32, bits 4:0
V3 = R0x33, bits 4:0
V4 = R0x34, bits 4:0
$^{t}INT = {}^{t}1 + {}^{t}2 + {}^{t}3$

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There are two ways to specify the knee points timing, the first by manual setting (default) and the second by automatic knee point adjustment.

When the auto adjust enabler is set to HIGH (LOW by default), the MT9V032 calculates the knee points automatically using the following equations:

$^{t}1 = {}^{t}INT - {}^{t}2 - {}^{t}3$
$^{t}2 = {}^{t}INT \times (½)^{R0x0A, bits 3:0}$
$^{t}3 = {}^{t}INT \times (½)^{R0x0A, bits 7:4}$

As a default for auto exposure, $^{t}2$ is 1/16 of ^{t}INT, $^{t}3$ is 1/64 of ^{t}INT.

When the auto adjust enabler is disabled (default), $^{t}1$, $^{t}2$, and $^{t}3$ may be programmed through the two-wire serial interface:

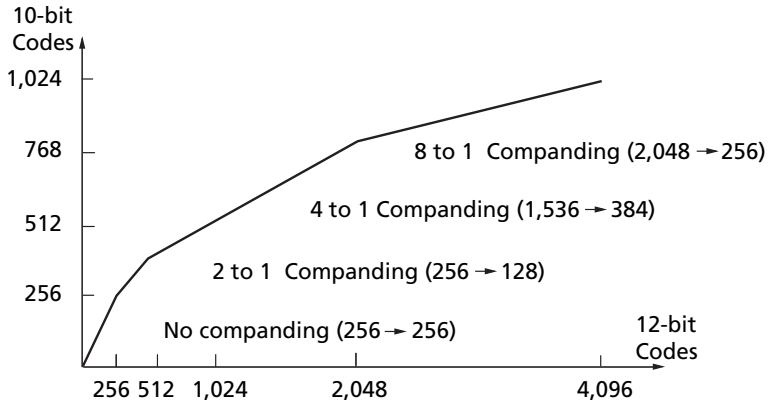
$^{t}1$ = R0x08, bits 14:0
$^{t}2$ = (R0x09, bits 14:0) - (R0x08, bits 14:0)
$^{t}3 = {}^{t}INT - {}^{t}1 - {}^{t}2$

^{t}INT may be based on the manual setting of R0x0B or the result of the AEC. If the AEC is enabled then the auto knee adjust must also be enabled.

Variable ADC Resolution

By default, ADC resolution of the sensor is 10-bit. Additionally, a companding scheme of 12-bit into 10-bit is enabled by the R0x1C (28). This mode allows higher ADC resolution which means less quantization noise at low-light, and lower resolution at high-light, where good ADC quantization is not so critical because of the high level of the photon's shot noise.

Figure 23: 12- to 10-Bit Companding Chart



Gain Settings

Changes to Gain Settings

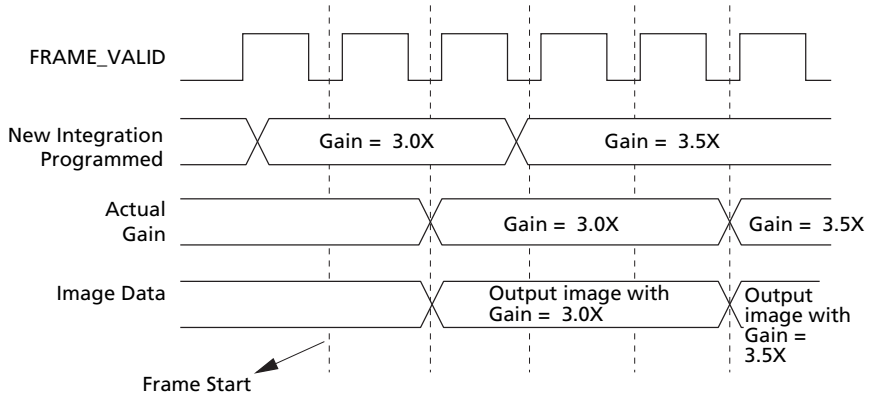
When the digital gain settings (R0x80–R0x98) are changed, the gain is updated on the next frame start. However, the latency for an analog gain change to take effect depends on the automatic gain control.

If automatic gain control is enabled (R0xAF, bit 1 is set to HIGH), the gain changed for frame *n* first appears in frame (*n* + *1*); if the automatic gain control is disabled, the gain changed for frame n first appears in frame (*n* + *2*).

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Both analog and digital gain change regardless of whether the integration time is also changed simultaneously.

Figure 24: Latency of Analog Gain Change When AGC is Disabled



Analog Gain

R0x35 Global Gain

Formula for gain setting:
Gain = Bits[6:0] x 0.0625

The analog gain range supported in the MT9V032 is 1X–4X with a step size of 6.25 percent. In order to manually control gain with this register, the sensor must NOT be in AGC mode. When adjusting the luminosity of an image, it is recommended to alter exposure first and yield to gain increases only when the exposure value has reached a maximum limit.

Analog gain = bits (6:0) x 0.0625 for values 16–31

Analog gain = bits (6:0)/2 x 0.125 for values 32–64

For values 16–31: each LSB increases analog gain 0.0625v/v. A value of 16 = 1X gain. Range: 1X to 1.9375X.

For values 32–64: each 2 LSB increases analog gain 0.125v/v (i.e. double the gain increase for 2 LSB). Range: 2X to 4X. Odd values do not result in gain increases, the gain increases by 0.125 for values: 32, 34, 36, etc. Caution should be taken when programming this register.

Digital Gain

R0x80–R0x98 Tiled Digital Gain and Weight, R0x99–R0xA4 Tile Coordinates

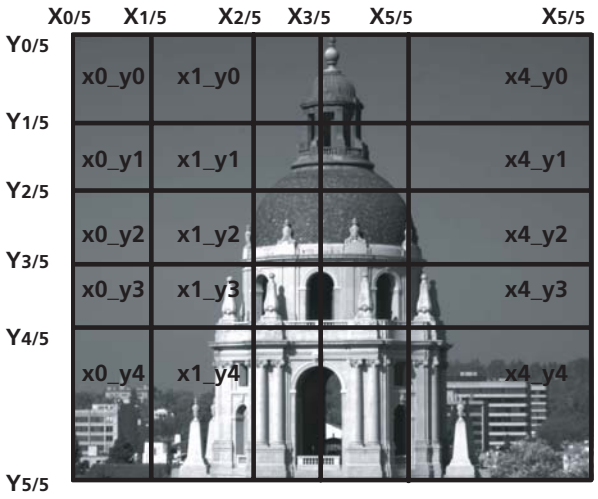
In the MT9V032, the image may be divided into 25 tiles, as shown in Figure 25, through the two-wire serial interface, and apply digital gain individually to each tile.

Registers 0x99–0x9E and 0x9F–0xA4 represent the coordinates $X_{0/5}$-$X_{5/5}$ and $Y_{0/5}$-$Y_{5/5}$ in Figure 25, respectively. Digital gains of Registers 0x80–0x98 applies to their corresponding tiles. The MT9V032 supports a digital gain of 0.25-3.75X.

Formula for digital gain setting:
Digital Gain = Bits[3:0] x 0.25

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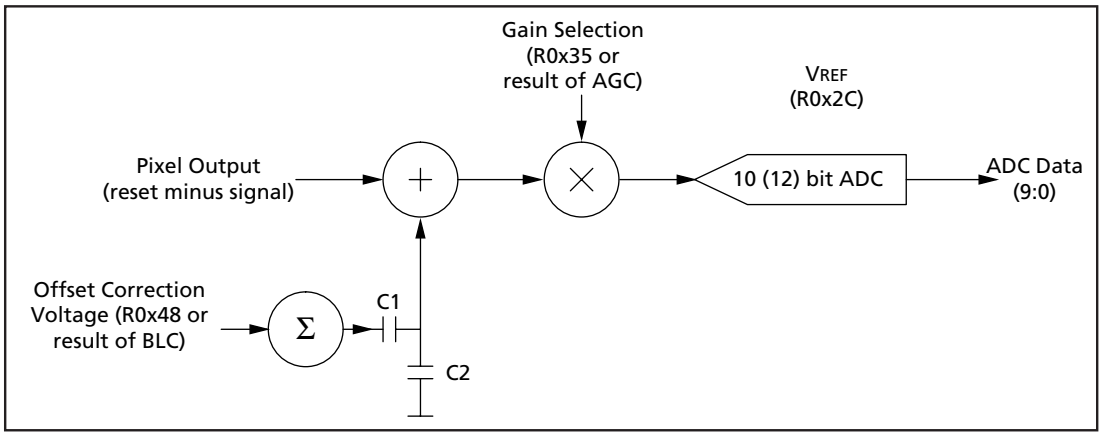
Figure 25: Tiled Sample



Black Level Calibration

R0x42, R0x46–0x48, R0x4C

Figure 26: Black Level Calibration Flow Chart



The MT9V032 has automatic black level calibration on-chip, and if enabled, its result may be used in the offset correction shown in Figure 26.

The automatic black level calibration measures the average value of pixels from 2 dark rows (1 dark row if row bin 4 is enabled) of the chip. (The pixels are averaged as if they were light sensitive and passed through the appropriate gain.) This row average is then digitally low-pass filtered over many frames (R0x47, bits 7:5) to remove temporal noise and random instabilities associated with this measurement.

Then, the new filtered average is compared to a minimum acceptable level, low threshold, and a maximum acceptable level, high threshold. If the average is lower than the minimum acceptable level, the offset correction voltage is increased by a programmable offset LSB in R0x4C. (Default step size is 2 LSB Offset = 1 ADC LSB at analog gain = 1X.) If it is above the maximum level, the offset correction voltage is decreased by 2 LSB

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(default). To avoid oscillation of the black level from below to above, the region the thresholds should be programmed so the difference is at least two times the offset DAC step size.

In normal operation, the black level calibration value/offset correction value is calculated at the beginning of each frame and can be read through the two-wire serial interface from R0x48. This register is an 8-bit signed two's complement value. However, if R0x47, bit 0 is set to "1," the calibration value in R0x48 may be manually set to override the automatic black level calculation result. This feature can be used in conjunction with the "show dark rows" feature (R0x0D, bit 6) if using an external black level calibration circuit. The offset correction voltage is generated according to the following formula:

Offset Correction Voltage = (8-bit signed two's complement calibration value, -127 to 127) × 0.5mV

ADC input voltage = (Pixel Output Voltage + Offset Correction Voltage) × Analog Gain

Row-wise Noise Correction

R0x70 Row Noise Control, R0x72 Row noise Constant, and R0x73 Dark Column Start

When the row-wise noise cancellation algorithm is enabled, the average value of the dark columns read out is used as a correction for the whole row. The row-wise correction is in addition to the general black level correction applied to the whole sensor frame and cannot be used to replace the latter. The dark average is subtracted from each pixel belonging to the same row, and then a positive constant is added (R0x72, bits 7:0). This constant should be set to the dark level targeted by the black level algorithm plus the noise expected on the measurements of the averaged values from dark columns; it is meant to prevent clipping from negative noise fluctuations.

Pixel value = ADC value - dark column average + row noise constant

On a per-row basis, the dark column average is calculated from a programmable number of dark columns (pixels) values (R0x70, bits 3:0). The default is 10 dark columns. Of these, the maximum and minimum values are removed and then the average is calculated. If R0x70, bits 3:0 are set to 0 (2 pixels), it is essentially equivalent to disabling the dark average calculation since the average is equal to 0 after the maximum and minimum values are removed.

R0x73 is used to indicate the starting column address of dark pixels which row-noise correction algorithm uses for calculation. In the MT9V032, dark columns which may be used are 759–776. R0x73 is used to select the starting column for the calculation.

One additional note in setting the row-noise correction register:

777 < (R0x73, bits 9:0) + number of dark pixels programmed in R0x70, bits 3:0 -1

This is to ensure the column pointer does not go beyond the limit the MT9V032 can support.

Automatic Gain Control (AGC) and Automatic Exposure Control (AEC)

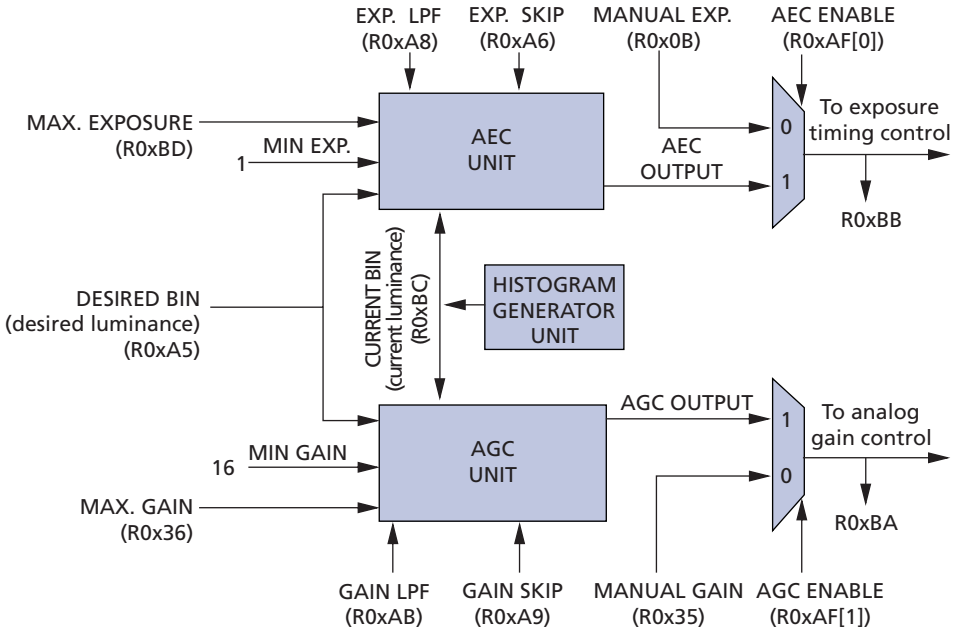
Operation Details

The integrated AEC/AGC unit is responsible for ensuring that optimal auto settings of exposure and (analog) gain are computed and updated every frame.

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AEC and AGC can be individually enabled or disabled by R0xAF. When AEC is disabled (R0xAF[0] = 0), the sensor uses the manual exposure value in R0x0B. When AGC is disabled (R0xAF[1] = 0), the sensor uses the manual gain value in R0x35. See Micron Technical Note TN-09-17, "MT9V032 AEC and AGC Functions," for further details.

Figure 27: Controllable and Observable AEC/AGC Registers



The exposure is measured in row-time by reading R0xBB. The exposure range is 1 to 2047. The gain is measured in gain-units by reading R0xBA. The gain range is 16 to 63 (unity gain = 16 gain-units; multiply by 1/16 to get the true gain).

When AEC is enabled (R0xAF[0] = 1), the maximum auto exposure value is limited by R0xBD; minimum auto exposure is fixed at 1 row.

When AGC is enabled (R0xAF[1] = 1), the maximum auto gain value is limited by R0x36; minimum auto gain is fixed to 16 gain-units.

The exposure control measures current scene luminosity and desired output luminosity by accumulating a histogram of pixel values while reading out a frame. The desired exposure and gain are then calculated from this for subsequent frame.

Pixel Clock Speed

The pixel clock speed is same as the master clock (SYSCLK) at 26.66 MHz by default. However, when column binning 2 or 4 (R0x0D, bit 2 or 3) is enabled, the pixel clock speed is reduced by half and one-fourth of the master clock speed respectively. See "Read Mode Options" on page 43 and "Column Bin" on page 44 for additional information.

Hard Reset of Logic

The RC circuit for the MT9V032 uses a 10kΩ resistor and a 0.1µF capacitor. The rise time for the RC circuit is 1µs maximum.

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Soft Reset of Logic

R0x0C Reset

Bit 0 is used to reset the digital logic of the sensor while preserving the existing two-wire serial interface configuration. Furthermore, by asserting the soft reset, the sensor aborts the current frame it is processing and start a new frame. Bit 1 is a shadowed reset control register bit to explicitly reset the automatic gain and exposure control feature.

These two bits are self-resetting bits and also returns to “0” during two-wire serial interface reads.

STANDBY Control

The sensor goes into standby mode by setting STANDBY to HIGH. Once the sensor detects that STANDBY is asserted, it completes the current frame before disabling the digital logic, internal clocks, and analog power enable signal. To release the sensor out from the standby mode, reset STANDBY back to LOW. The LVDS must be powered to ensure that the device is in standby mode. Please see "Appendix B – Power-On Reset and Standby Timing" on page 59 for more information on standby.

Monitor Mode Control

R0x0E Monitor Mode Enable, R0xC0 Monitor Mode Image Capture Control

The sensor goes into monitor mode when R0x0E bit 0 is set to HIGH. In this mode, the sensor first captures a programmable number of frames (R0xC0), then goes into a sleep period for five minutes. The cycle of sleeping for five minutes and waking up to capture a number of frames continues until R0x0E bit 0 is cleared to return to normal operation.

In some application when monitor mode is enabled, the purpose of capturing frames is to calibrate the gain and exposure of the scene using automatic gain and exposure control feature. This feature typically takes less than 10 frames to settle. In case a larger number of frames is needed, the value of R0xC0 may be increased to capture more frames.

During sleep period, none of the analog circuitry and a very small fraction of digital logic (including a 5-minute timer) is powered. The master clock (SYSCLK) is therefore always required.

Read Mode Options

(Also see “Output Data Format” on page 6 and “Output Data Timing” on page 7.)

Column Flip

By setting bit 5 of R0x0D the readout order of the columns is reversed, as shown in Figure 28 on page 43.

Row Flip

By setting bit 4 of R0x0D the readout order of the rows is reversed, as shown in Figure 29 on page 44.

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Figure 28: Readout of Six Pixels in Normal and Column Flip Output Mode

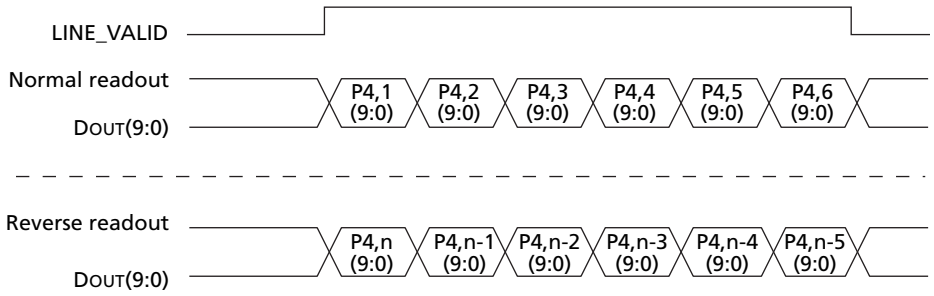
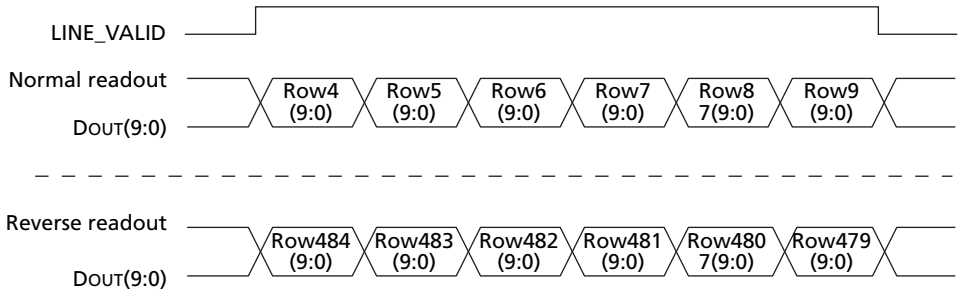


Figure 29: Readout of Six Rows in Normal and Row Flip Output Mode



Pixel Binning

In addition to windowing mode in which smaller resolution (CIF, QCIF) is obtained by selecting small window from the sensor array, the MT9V032 also provides the ability to show the entire image captured by pixel array with smaller resolution by pixel binning. Pixel binning is based on combining signals from adjacent pixels by averaging. There are two options: binning 2 and binning 4. When binning 2 is on 4 pixel signals from 2 adjacent rows and columns are combined. In case of binning 4 mode 16 pixels are combined from 4 adjacent rows and columns. The image mode may work in conjunction with image flip. The binning operation increases SNR but decreases resolution.

Enabling row bin2 and row bin4 improves frame rate by 2x and 4x respectively. The feature of column binning does not increase the frame rate in less resolution modes.

Row Bin

By setting bit 0 or 1 of R0x0D only half or one-fourth of the row set is read out, as shown in figure below. The number of rows read out is half or one-fourth of what is set in R0x03

Column Bin

In setting bit 2 or 3 of R0x0D, the pixel data rate is slowed down by a factor of either two or four, respectively. This is due to the overhead time in the digital pixel data processing chain. As a result, the pixel clock speed is also reduced accordingly.

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Figure 30: Readout of Eight Pixels in Normal and Row Bin Output Mode

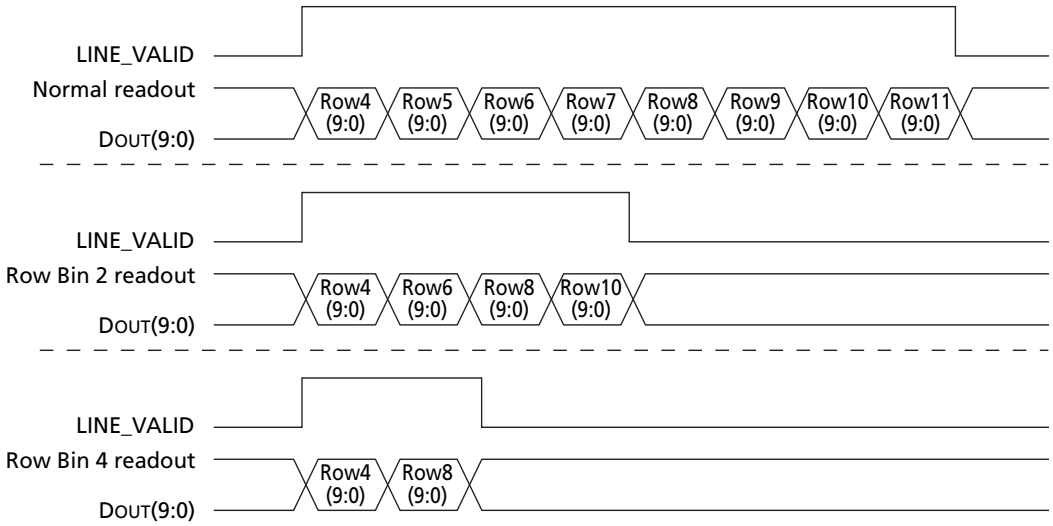
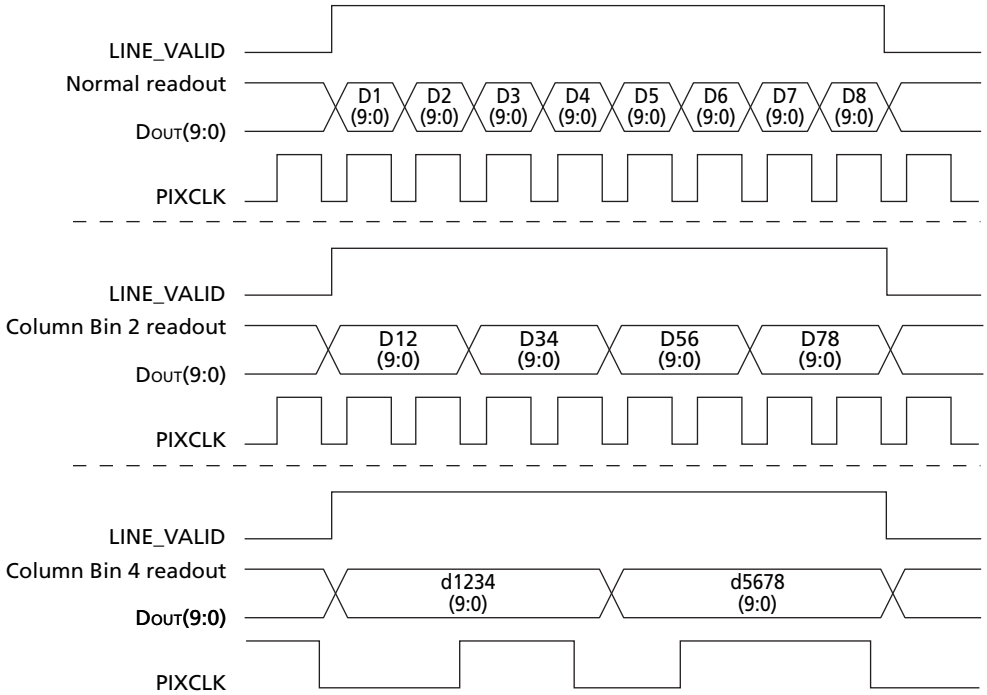


Figure 31: Readout of Eight Pixels in Normal and Column Bin Output Mode

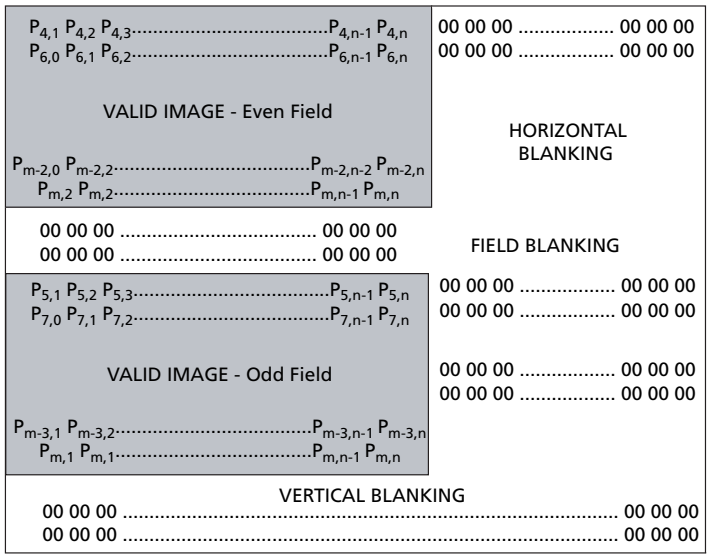


Interlaced Readout

The MT9V032 has two interlaced readout options. By setting R0x07[2:0] = 1, all the even-numbered rows is read out first, followed by a number of programmable field blanking (R0xBF, bits 7:0), and then the odd-numbered rows and finally vertical blanking (minimum is 4 blanking rows). By setting R0x07[2:0] = 2 only one field is read out, consequently, the number of rows read out is half what is set in R0x03. The row start address (R0x02) determines which field gets read out; if row start address is even, even field is read out; if row start address is odd, odd field is read out.

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Figure 32: Spatial Illustration of Interlaced Image Readout



When interlaced mode is enabled, the total number of blanking rows are determined by both field blanking register (R0xBF) and vertical blanking register (R0x06). The followings are their equations.

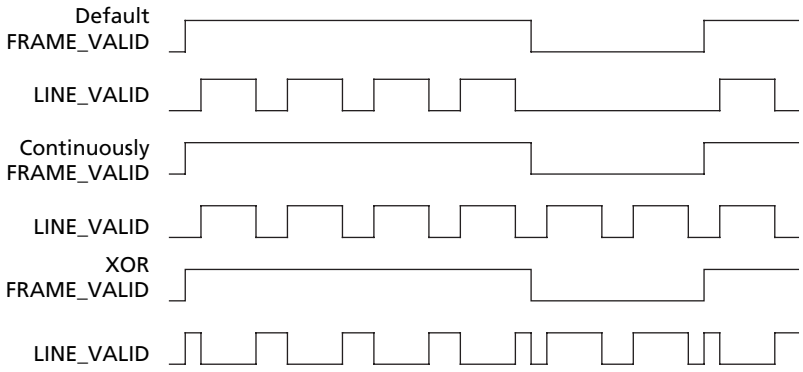
Field Blanking = R0xBF, bits 7:0
Vertical Blanking = R0x06, bits 8:0 -R0xBF, bits 7:0,
with minimum vertical blanking requirement = 4

Similar to progressive scan, FRAME_VALID is logic LOW during the valid image row only. Binning should not be used in conjunction with interlaced mode.

LINE_VALID

By setting bit 2 and 3 of R0x74 the LINE_VALID signal can get three different output formats. The formats for reading out four rows and two vertical blanking rows are shown in Figure 33. In the last format, the LINE_VALID signal is the XOR between the continuous LINE_VALID signal and the FRAME_VALID signal.

Figure 33: Different LINE_VALID Formats



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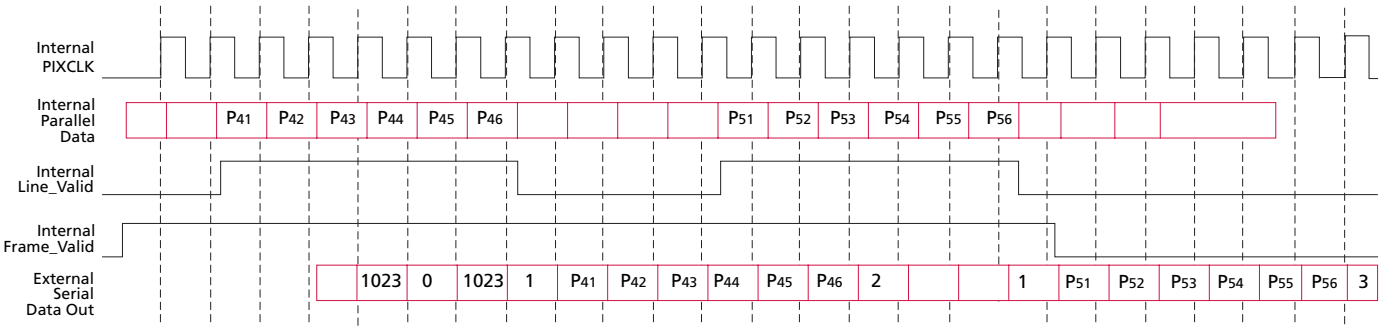
LVDS Serial (Stand-Alone/Stereo) Output

The LVDS interface allows for the streaming of sensor data serially to a standard off-the-shelf deserializer up to five meters away from the sensor. The pixels (and controls) are packeted—12-bit packets for stand-alone mode and 18-bit packets for stereoscopy mode. All serial signalling (CLK and data) is LVDS. The LVDS serial output could either be data from a single sensor (stand-alone) or stream-merged data from two sensors (self and its stereoscopic slave pair). The appendices describe in detail the topologies for both stand-alone and stereoscopic modes.

There are two standard deserializers that can be used. One for a stand-alone sensor stream and the other from a stereoscopic stream. The deserializer attached to a stand-alone sensor is able to reproduce the standard parallel output (8-bit pixel data, LINE_VALID, FRAME_VALID and PIXCLK). The deserializer attached to a stereoscopic sensor is able to reproduce 8-bit pixel data from each sensor (with embedded LINE_VALID and FRAME_VALID) and pixel-clk. An additional (simple) piece of logic is required to extract LINE_VALID and FRAME_VALID from the 8-bit pixel data. Irrespective of the mode (stereoscopy/stand-alone), LINE_VALID and FRAME_VALID are always embedded in the pixel data.

In stereoscopic mode, the two sensors run in lock-step, implying all state machines are in the same state at any given time. This is ensured by the sensor-pair getting their sys-clks and sys-resets in the same instance. Configuration writes through the two-wire serial interface are done in such a way that both sensors can get their configuration updates at once. The inter-sensor serial link is designed in such a way that once the slave PLL locks and the data-dly, shft-clk-dly and stream-latency-sel are configured, the master sensor streams good stereo content irrespective of any variation voltage and/or temperature as long as it is within specification. The configuration values of data-dly, shft-clk-dly and stream-latency-sel are either pre-determined form the board-layout or can be empirically determined by reading back the stereo-error flag. This flag gets asserted when the two sensor streams are not in sync when merged. The combo_reg is used for out-of-sync diagnosis.

Figure 34: Serial Output Format for a 6x2 Frame



Notes:
1. External pixel values of 0, 1, 2, 3, are reserved (they only convey control information). Any raw pixel of value 0, 1, 2 and 3 will be substituted with 4.
2. The external pixel sequence 1023, 0 1023 is a reserved sequence (conveys control information). Any raw pixel sequence of 1023, 0, 1023 will be substituted with 1023, 4, 1023.

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LVDS Output Format

In stand-alone mode, the packet size is 12 bits (2 frame bits and 10 payload bits); 10-bit pixels or 8-bit pixels can be selected. In 8-bit pixel mode (R0xB6[0] = 0), the packet consists of a start bit, 8-bit pixel data (with sync codes), the line valid bit, the frame valid bit and the stop bit. For 10-bit pixel mode (R0xB6[0] = 1), the packet consists of a start bit, 10-bit pixel data, and the stop bit.

Table 9: LVDS Packet Format in Stand-Alone Mode
(Stereoscopy Mode Bit De-Asserted)

12-Bit Packet	use_10-bit_pixels Bit De-Asserted (8-Bit Mode)	use_10-bit_pixels Bit Asserted (10-Bit Mode)
Bit[0]	1'b1 (Start bit)	1'b1 (Start bit)
Bit[1]	PixelData[2]	PixelData[0]
Bit2]	PixelData[3]	PixelData[1]
Bit[3]	PixelData[4]	PixelData[2]
Bit4]	PixelData[5]	PixelData[3]
Bit[5]	PixelData[6]	PixelData[4]
Bit[6]	PixelData[7]	PixelData[5]
Bit[7]	PixelData[8]	PixelData[6]
Bit[8]	PixelData[9]	PixelData[7]
Bit[9]	Line_Valid	PixelData[8]
Bit[10]	Frame_Valid	PixelData[9]
Bit[11]	1'b0 (Stop bit)	1'b0 (Stop bit)

In stereoscopic mode (see Figure 47 on page 57), the packet size is 18 bits (2 frame bits and 16 payload bits). The packet consists of a start bit, the master pixel byte (with sync codes), the slave byte (with sync codes), and the stop bit.)

Table 10: LVDS Packet Format in Stereoscopy Mode (Stereoscopy Mode Bit Asserted)

18-bit Packet	Function
Bit[0]	1'b1 (Start bit)
Bit[1]	MasterSensorPixelData[2]
Bit[2]	MasterSensorPixelData[3]
Bit[3]	MasterSensorPixelData[4]
Bit[4]	MasterSensorPixelData[5]
Bit[5]	MasterSensorPixelData[6]
Bit[6]	MasterSensorPixelData[7]
Bit[7]	MasterSensorPixelData[8]
Bit[8]	MasterSensorPixelData[9]
Bit[9]	SlaveSensorPixelData[2]
Bit[10]	SlaveSensorPixelData[3]
Bit[11]	SlaveSensorPixelData[4]
Bit[12]	SlaveSensorPixelData[5]
Bit[13]	SlaveSensorPixelData[6]
Bit[14]	SlaveSensorPixelData[7]
Bit[15]	SlaveSensorPixelData[8]
Bit[16]	SlaveSensorPixelData[9]
Bit[17]	1'b0 (Stop bit)

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Control signals LINE_VALID and FRAME_VALID can be reconstructed from their respective preceding and succeeding flags that are always embedded within the pixel data in the form of reserved words.

Table 11: Reserved Words in the Pixel Data Stream

Pixel Data Reserved Word	Flag
0	Precedes frame valid assertion
1	Precedes line valid assertion
2	Succeeds line valid de-assertion
3	Succeeds frame valid de-assertion

When LVDS mode is enabled along with column binning (bin 2 or bin 4, R0x0D[3:2], the packet size remains the same but the serial pixel data stream repeats itself depending on whether 2X or 4X binning is set:

- For bin 2, LVDS outputs double the expected data (pixel 0,0 is output twice in sequence, followed by pixel 0,1 twice, . . .).
- For bin 4, LVDS outputs 4 times the expected data (pixel 0,0 is output 4 times in sequence followed by pixel 0,1 times 4, . . .).

The receiving hardware will need to under sample the output stream getting data either every 2 clocks (bin 2) or every 4 (bin 4) clocks.

If the sensor provides a pixel whose value is 0,1, 2, or 3 (that is, the same as a reserved word) then the outgoing serial pixel value is switched to 4.

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Electrical Specifications

Table 12: DC Electrical Characteristics

V_{PWR} = 3.3V ±0.3V; T_A = Ambient = 25°C

Symbol	Definition	Condition	MIN	TYP	MAX	Unit
V_{IH}	Input high voltage		V_{PWR} -0.5	–	V_{PWR} +0.3	V
V_{IL}	Input low voltage		-0.3	–	0.8	V
I_{IN}	Input leakage current	No pull-up resistor; V_{IN} = V_{PWR} or V_{GND}	-15.0	–	15.0	µA
V_{OH}	Output high voltage	I_{OH} = -4.0mA	V_{PWR} -0.7	–	–	V
V_{OL}	Output low voltage	I_{OL} = 4.0mA	–	–	0.3	V
I_{OH}	Output high current	V_{OH} = V_{DD} - 0.7	-9.0	–	–	mA
I_{OL}	Output low current	V_{OL} = 0.7	–	–	9.0	mA
V_{AA}	Analog power supply	Default settings	3.0	3.3	3.6	V
I_{PWRA}	Analog supply current	Default settings	–	35.0	60.0	mA
V_{DD}	Digital power supply	Default settings	3.0	3.3	3.6	V
I_{PWRD}	Digital supply current	Default settings, C_{LOAD}= 10pF	—	35.0	60	mA
VAAPIX	Pixel array power supply	Default settings	3.0	3.3	3.6	V
I_{PIX}	Pixel supply current	Default settings	0.5	1.4	3.0	mA
V_{LVDS}	LVDS power supply	Default settings	3.0	3.3	3.6	V
I_{LVDS}	LVDS supply current	Default settings	11.0	13.0	15.0	mA
I_{PWRA} Standby	Analog standby supply current	STDBY = V_{DD}	2	3	4	µA
I_{PWRD} Standby Clock Off	Digital standby supply current with clock off	STDBY = V_{DD}, CLKIN = 0 MHz	1	2	4	µA
I_{PWRD} Standby Clock On	Digital standby supply current with clock on	STDBY= V_{DD}, CLKIN = 27 MHz	–	1.05	–	mA
LVDS Driver DC Specifications						
|V_{OD}|	Output differential voltage	R_{LOAD} = 100 Ω ±1%	250	–	400	mV
|DV_{OD}|	Change in V_{OD} between complementary output states		–	–	50	mV
V_{OS}	Output offset voltage		1.0	1.2	1.4	mV
DV_{OS}	Change in V_{OS} between complementary output states		–	–	35	mV
I_{OS}	Output current when driver shorted to ground			±10	±12	mA
I_{OZ}	Output current when driver is tri-state			±1	±10	µA
LVDS Receiver DC Specifications						
V_{IDTH+}	Input differential	| V_{GPD}| <925mV	-100	–	100	mV
Iin	Input current		–	–	±20	µA

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Table 13: Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Unit
V_{SUPPLY}	Power supply voltage (all supplies)	-0.3	4.5	V
I_{SUPPLY}	Total power supply current	–	200	mA
I_{GND}	Total ground current	–	200	mA
V_{IN}	DC input voltage	-0.3	V_{DDQ} + 0.3	V
V_{OUT}	DC output voltage	-0.3	V_{DDQ} + 0.3	V
T_{STG}[1]	Storage temperature	-40	+125	°C

Notes: 1.Stresses greater than those listed may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Table 14: AC Electrical Characteristics

V_{PWR} = 3.3V ±0.3V; T_A = Ambient = 25°C; Output Load = 10pF

Symbol	Definition	Condition	Min	Typ	Max	Unit
SYSCLK	Input clock frequency	Note 1	13.0	26.6	27.0	MHz
	Clock duty cycle		45.0	50.0	55.0	%
^tR	Input clock rise time		1	2	5	ns
^tF	Input clock fall time		1	2	5	ns
^tPLHP	SYSCLK to PIXCLK propagation delay	C_{LOAD} = 10pF	3	7	11	ns
^tPD	PIXCLK to valid D_{OUT}(9:0) propagation delay	C_{LOAD} = 10pF	-2	0	2	ns
^tSD	Data setup time		14	16	–	ns
^tHD	Data hold time		14	16	–	
^tPFLR	PIXCLK to LINE_VALID propagation delay	C_{LOAD} = 10pF	-2	0	2	ns
^tPFLF	PIXCLK to FRAME_VALID propagation delay	C_{LOAD} = 10pF	-2	0	2	ns

Note: 1. The frequency range specified applies only to the parallel output mode of operation.

Propagation Delays for PIXCLK and Data Out Signals

The pixel clock is inverted and delayed relative to the master clock. The relative delay from the master clock (SYSCLK) rising edge to both the pixel clock (PIXCLK) falling edge and the data output transition is typically 7ns. Note that the falling edge of the pixel clock occurs at approximately the same time as the data output transitions. See Table 14 for data setup and hold times.

Propagation Delays for FRAME_VALID and LINE_VALID Signals

The LINE_VALID and FRAME_VALID signals change on the same rising master clock edge as the data output. The LINE_VALID goes HIGH on the same rising master clock edge as the output of the first valid pixel's data and returns LOW on the same master clock rising edge as the end of the output of the last valid pixel's data.

As shown in the “Output Data Timing” on page 7, FRAME_VALID goes HIGH 143 pixel clocks prior to the time that the first LINE_VALID goes HIGH. It returns LOW at a time corresponding to 23 pixel clocks after the last LINE_VALID goes LOW.

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Figure 35: Propagation Delays for PIXCLK and Data Out Signals

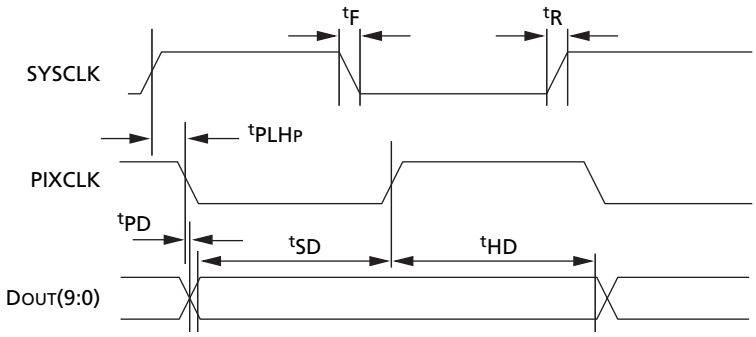
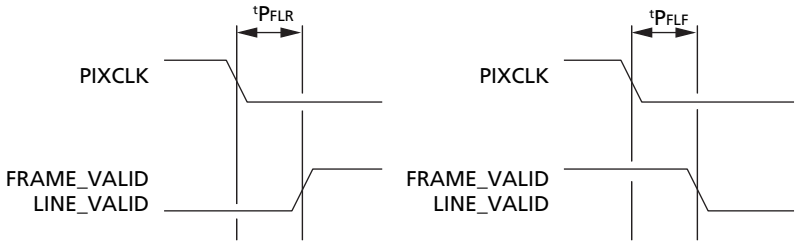


Figure 36: Propagation Delays for FRAME_VALID and LINE_VALID Signals



Two-Wire Serial Bus Timing

The two-wire serial bus operation requires certain minimum master clock cycles between transitions. These are specified in the following diagrams in master clock cycles.

Figure 37: Serial Host Interface Start Condition Timing

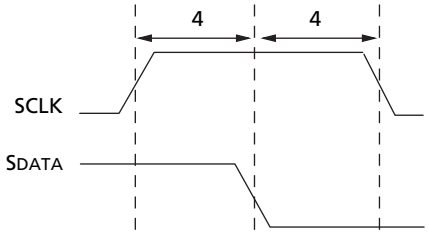
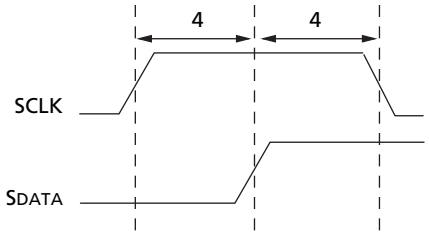


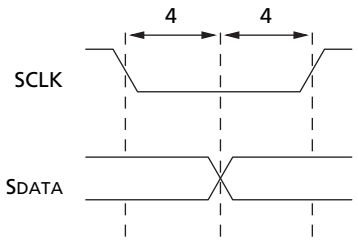
Figure 38: Serial Host Interface Stop Condition Timing



Note: All timing are in units of master clock cycle.

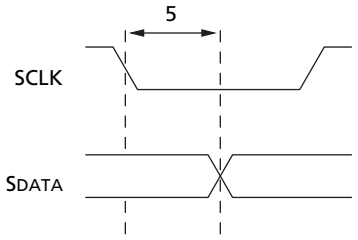
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Figure 39: Serial Host Interface Data Timing for Write



Note: SDATA is driven by an off-chip transmitter.

Figure 40: Serial Host Interface Data Timing for Read



Note: SDATA is pulled LOW by the sensor, or allowed to be pulled HIGH by a pull-up resistor off-chip.

Figure 41: Acknowledge Signal Timing After an 8-Bit Write to the Sensor

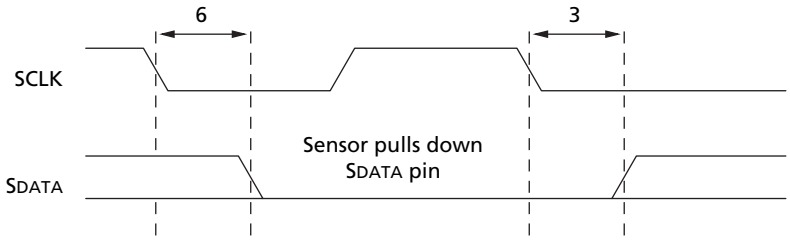
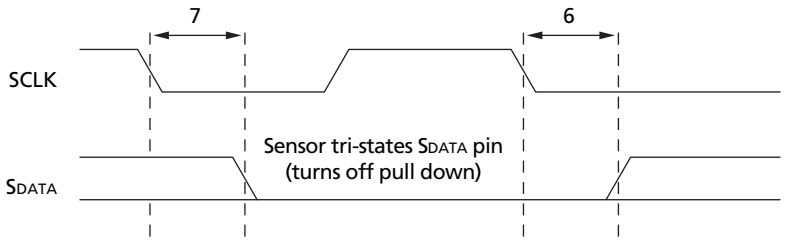


Figure 42: Acknowledge Signal Timing After an 8-Bit Read from the Sensor



Note: After a READ, the master receiver must pull down SDATA to acknowledge receipt of data bits. When read sequence is complete, the master must generate a "No Acknowledge" by leaving SDATA to float HIGH. On the following cycle, a start or stop bit may be used.

Temperature Reference

The MT9V032 contains a temperature reference circuit that can be used to measure relative temperatures. Please contact your Micron field applications engineer (FAE) for more information on using this circuit.

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Figure 43: Typical Quantum Efficiency—Color

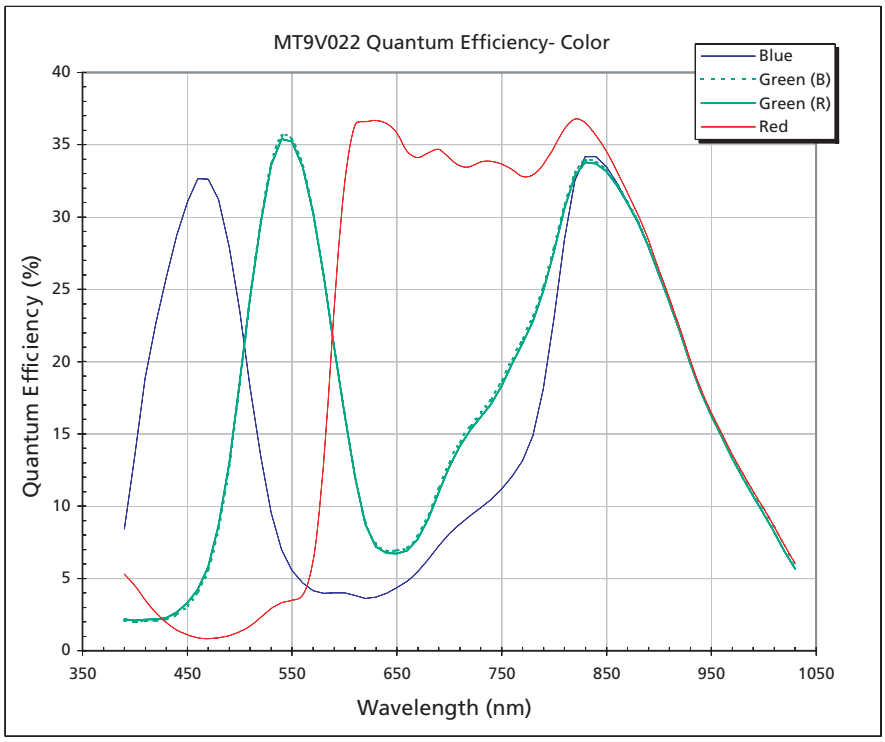
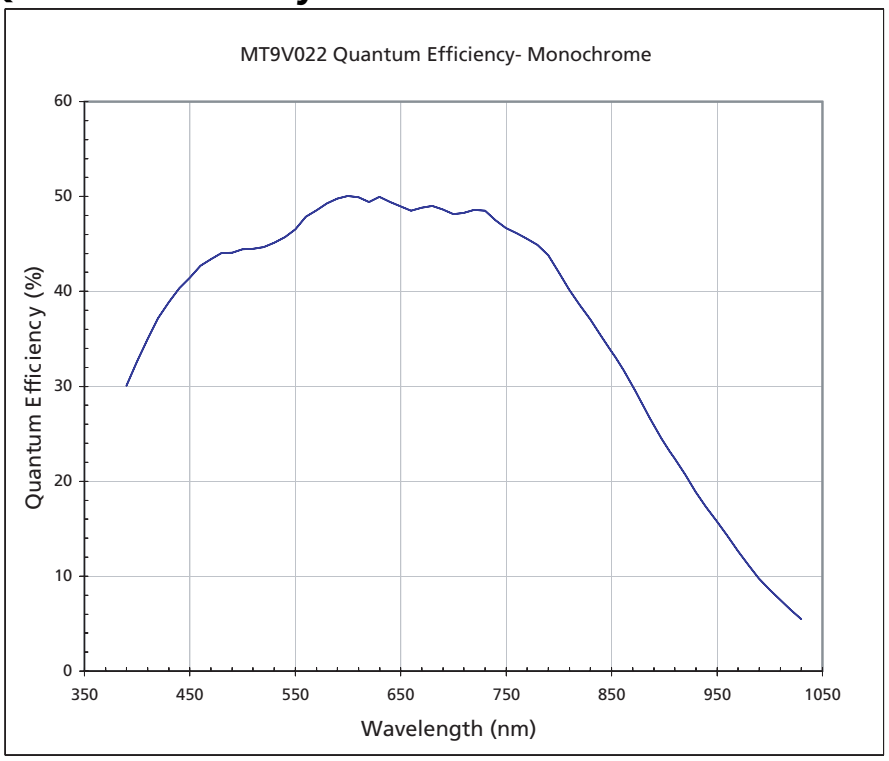


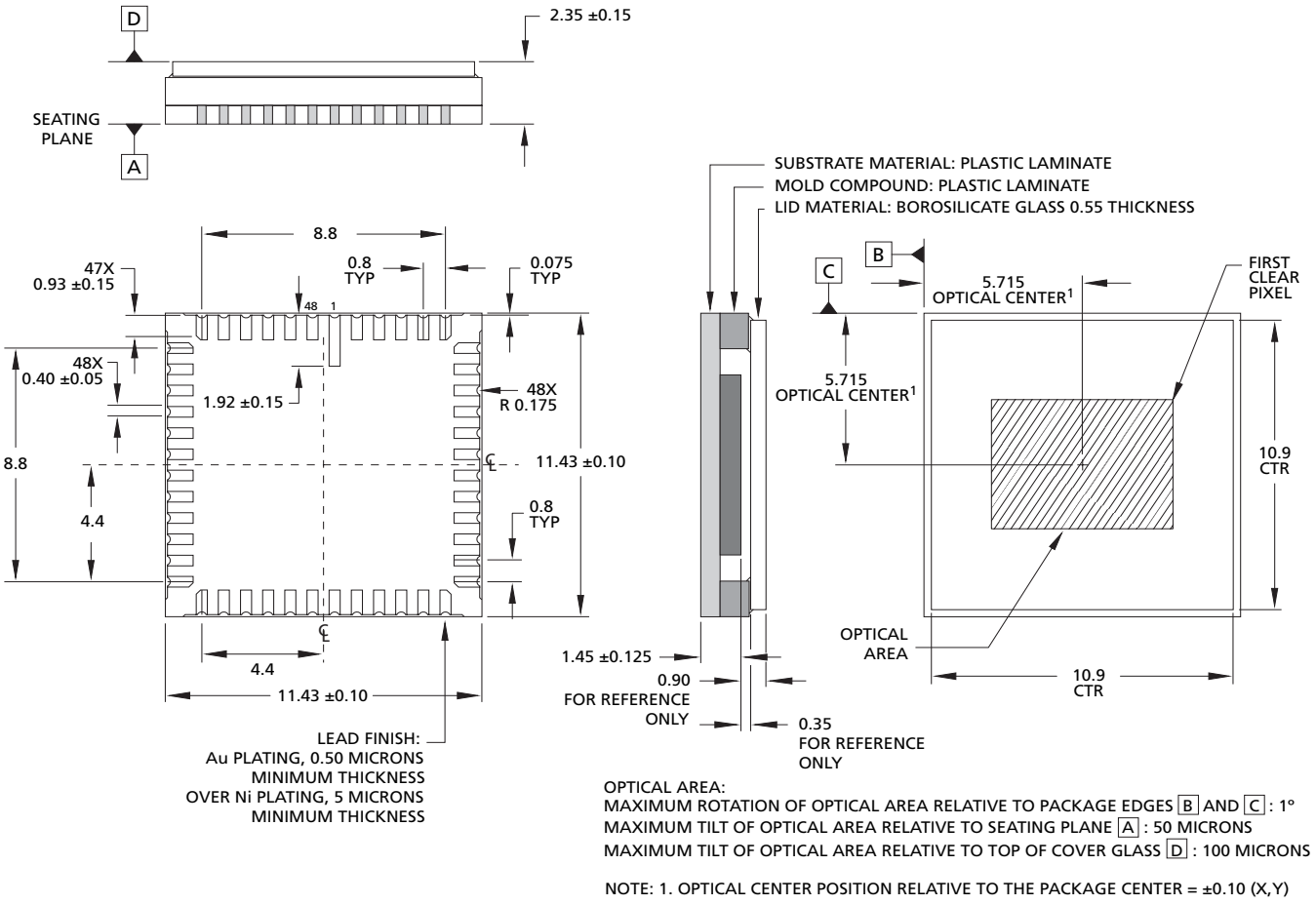
Figure 44: Typical Quantum Efficiency—Monochrome



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Package Dimensions

Figure 45: 48-Pin LLCC Package Outline Drawing



Notes: 1. All dimensions in millimeters.

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Appendix A – Serial Configurations

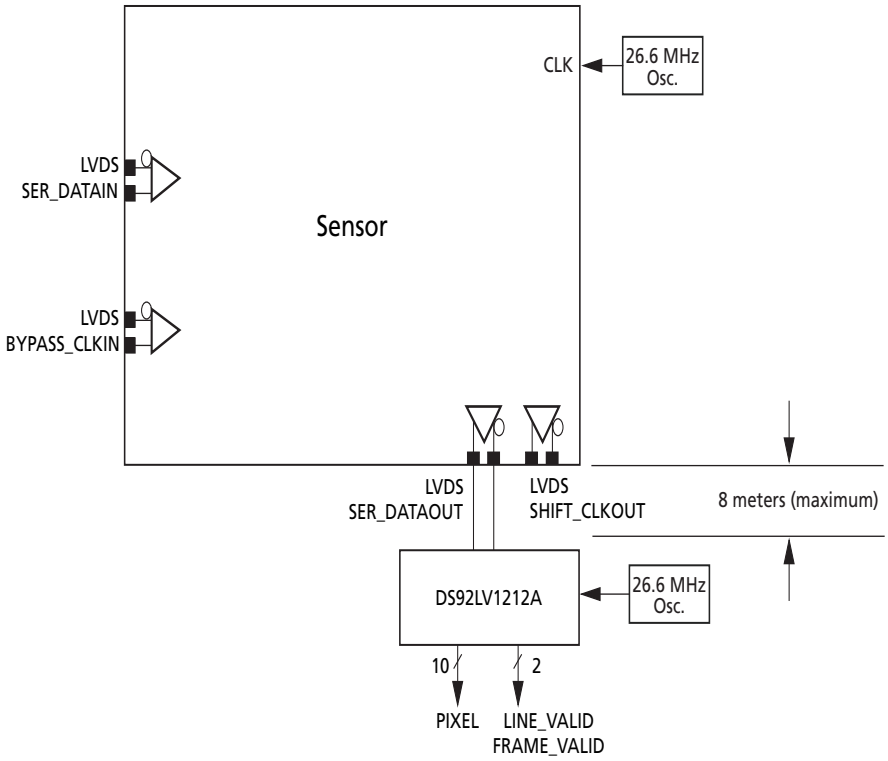
With the LVDS serial video output, the deserializer can be up to 8 meters from the sensor. The serial link can save on the cabling cost of 14 wires (DOUT[9:0], LINE_VALID, FRAME_VALID, PIXCLK, GND). Instead, just three wires (2 serial LVDS, 1 GND) are sufficient to carry the video signal.

Configuration of Sensor for Stand-Alone Serial Output with Internal PLL

In this configuration, the internal PLL generates the shift-clk (x12). The LVDS pins SER_DATAOUT_P and SER_DATAOUT_N must be connected to a deserializer (clocked at approximately the same system clock frequency).

Figure 46 shows how a standard off-the-shelf deserializer (National Semiconductor DS92LV1212A) can be used to retrieve back the standard parallel video signals of DOUT(9:0), LINE_VALID and FRAME_VALID.

Figure 46: Stand-Alone Topology



Typical configuration of the sensor:

1. Power-up sensor.
2. Enable LVDS driver (set R0xB3[4]= 0).
3. De-assert LVDS power-down (set R0xB1[1] = 0.
4. Issue a soft reset (set R0x0C[0] = 1 followed by R0x0C[0] = 0.

If necessary:

5. Force sync patterns for the de-serializer to lock (set R0xB5[0] = 1).
6. Stop applying sync patterns (set R0xB5[0] = 0).

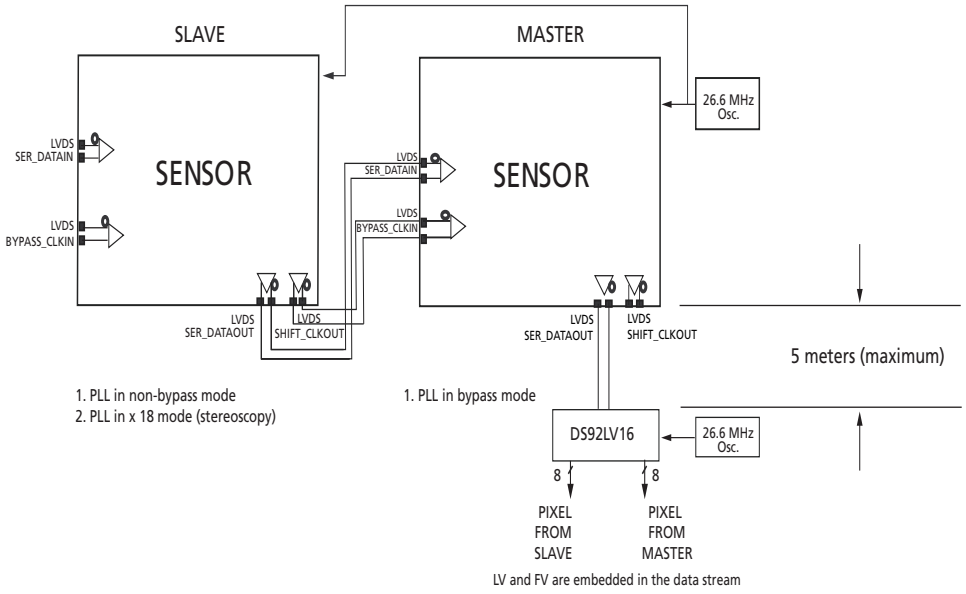
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Configuration of Sensor for Stereoscopic Serial Output with Internal PLL

In this configuration the internal PLL generates the shift-clk (x18) in phase with the system-clock. The LVDS pins SER_DATAOUT_P and SER_DATAOUT_N must be connected to a deserializer (clocked at approximately the same system clock frequency).

Figure 47 shows how a standard off-the-shelf deserializer can be used to retrieve back DOUT(9:2) for both the master and slave sensors. Additional logic is required to extract out LINE_VALID and FRAME_VALID embedded within the pixel data stream.

Figure 47: Stereoscopic Topology



Typical configuration of the master and slave sensors:

1. Power up the sensors.
2. Broadcast WRITE to de-assert LVDS power-down (set R0xB1[1] = 0).
3. Individual WRITE to master sensor putting its internal PLL into bypass mode (set R0xB1[0] = 1).
4. Broadcast WRITE to both sensors to set the stereoscopy bit (set R0x07[5] = 1).
5. Make sure all resolution, vertical blanking, horizontal blanking, window size, and AEC/AGC configurations are done through broadcast WRITE to maintain lockstep.
6. Broadcast WRITE to enable LVDS driver (set R0xB3[4] = 0).
7. Broadcast WRITE to enable LVDS receiver (set R0xB2[4] = 0).
8. Individual WRITE to master sensor, putting its internal PLL into bypass mode (set R0xB1[0] = 1).
9. Individual WRITE to slave sensor, enabling its internal PLL (set R0xB1[0] = 0).
10. Individual WRITE to slave sensor, setting it as a stereo slave (set R0x07[6] = 1).
11. Individual WRITEs to master sensor to minimize the inter-sensor skew (set R0xB2[2:0], R0xB3[2:0], and R0xB4[1:0] appropriately). Use R0xB7 and R0xB8 to get lockstep feedback from stereo_error_flag.
12. Broadcast WRITE to issue a soft reset (set R0x0C[0] = 1 followed by R0x0C[0] = 0).

Note: The stereo_error_flag is set if a mismatch has occurred at a reserved byte (slave and master sensor's codes at this reserved byte must match). If the flag is set, steps 11 and 12 are repeated until the stereo_error_flag remains cleared.

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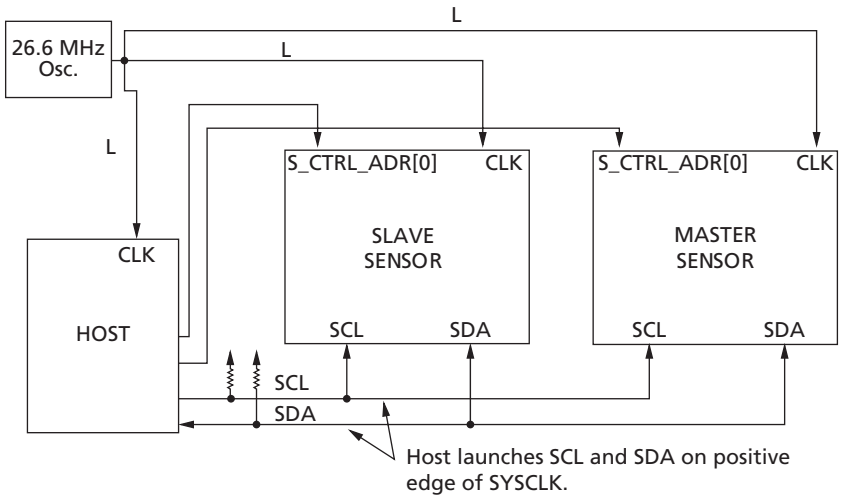
Broadcast and Individual Writes for Stereoscopic Topology

In stereoscopic mode, the two sensors are required to run in lockstep. This implies that control logic in each sensor is in exactly the same state as its pair on every clock. To ensure this, all inputs that affect control logic must be identical and arrive at the same time at each sensor.

These inputs include:

- system clock
- system reset
- two-wire serial interface clk - SCL
- two-wire serial interface data - SDA

Figure 48: Two-wire Serial Interface Configuration in Stereoscopic Mode



All system clock lengths (L) must be equal.
SCL and SDA lengths to each sensor (from the host) must also be equal.

The setup in Figure 48 shows how the two sensors can maintain lockstep when their configuration registers are written through the two-wire serial interface. A WRITE to configuration registers would either be broadcast (simultaneous WRITES to both sensors) or individual (WRITE to just one sensor at a time). READs from configuration registers would be individual (READs from just one sensor at a time).

One of the two serial interface slave address bits of the sensor is hardwired. The other is controlled by the host. This allows the host to perform either a broadcast or a one-to-one access.

Broadcast WRITES are performed by setting the same S_CTRL_ADR input bit for both slave and master sensor. Individual WRITES are performed by setting opposite S_CTRL_ADR input bit for both slave and master sensor. Similarly, individual READs are performed by setting opposite S_CTRL_ADR input bit for both slave and master sensor.

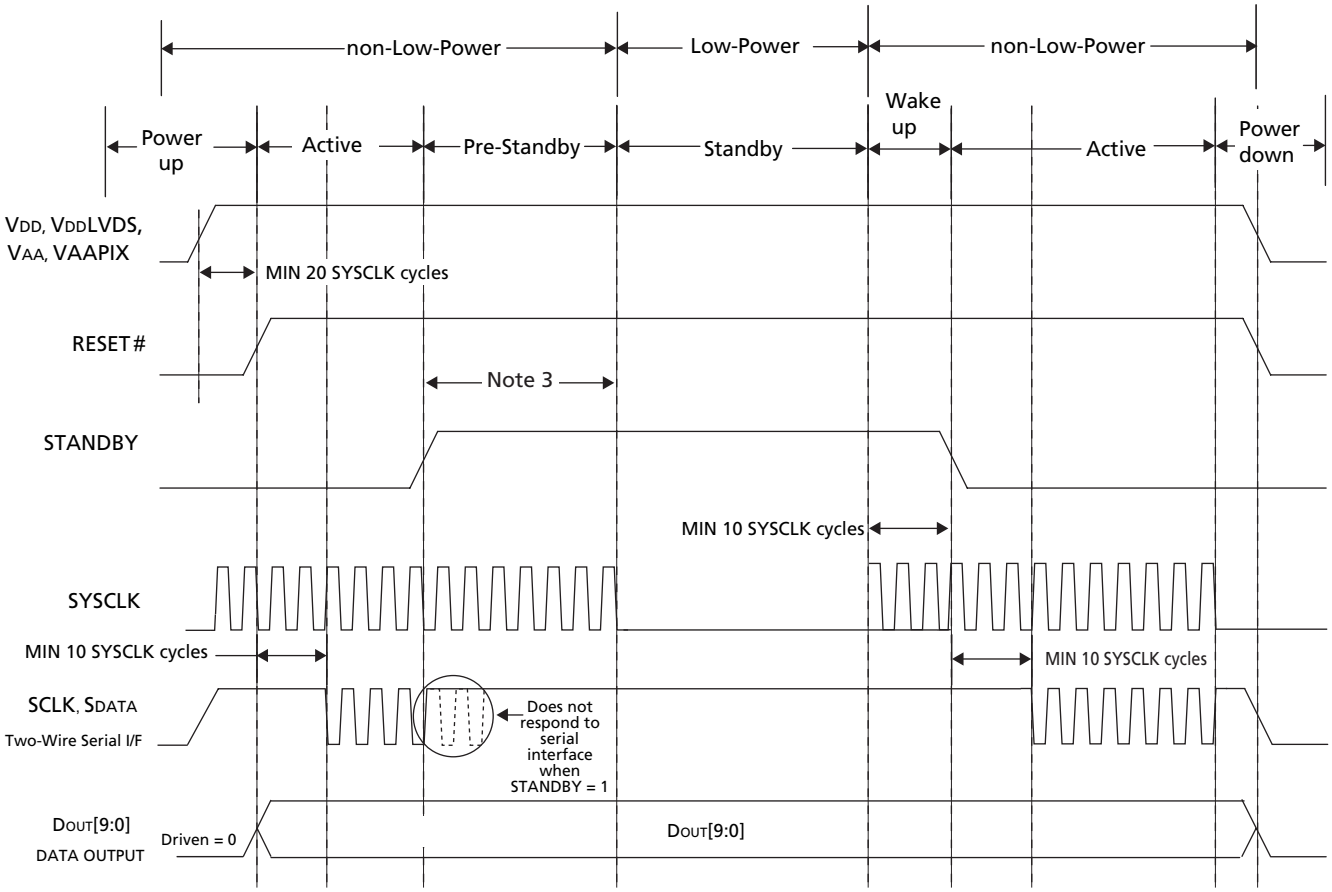
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Appendix B – Power-On Reset and Standby Timing

Reset, Clocks, and Standby

There are no constraints concerning the order in which the various power supplies are applied; however, the MT9V032 requires reset in order operate properly at power-up. Refer to Figure 49 for the power-up, reset, and standby sequences.

Figure 49: Power-up, Reset, Clock and Standby Sequence



Notes:
1. All output signals are defined during initial power-up with RESET# held LOW without SYSCLK being active. To properly reset the rest of the sensor, during initial power-up, assert RESET# (set to LOW state) for at least 750ns after all power supplies have stabilized and SYSCLK is active (being clocked). Driving RESET# to LOW state does not put the part in a low power state.
2. Before using two-wire serial interface, wait for 10 SYSCLK rising edges after RESET# is de-asserted.
3. Once the sensor detects that STANDBY has been asserted, it completes the current frame readout before entering standby mode. The user must supply enough SYSCLKs to allow a complete frame readout. See Table 4, "Frame Time," on page 7 for more information.
4. In standby, all video data and synchronization output signals are High-Z.
5. In standby, the two-wire serial interface is not active.

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Standby Assertion Restrictions

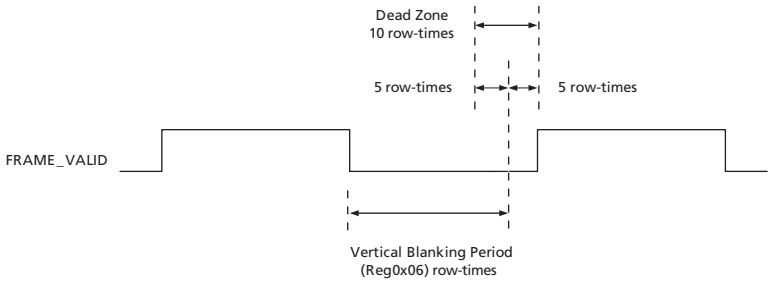
STANDBY cannot be asserted at any time. If STANDBY is asserted during a specific window within the vertical blanking period, the MT9V032 may enter a permanent standby state. This window (i.e. dead zone) occurs prior to the beginning of the new frame readout. The permanent standby state is identified by the absence of the FRAME_VALID signal on frame readouts. Issuing a hardware reset (RESET# set to LOW state) will return the image sensor to default startup conditions.

This dead zone can be avoided by:

1. Asserting STANDBY during the valid frame readout time (FRAME_VALID is HIGH) and maintaining STANDBY assertion for a minimum of one frame period.
2. Asserting STANDBY at the end of valid frame readout (falling edge of FRAME_VALID) and maintaining STANDBY assertion for a minimum of [5 + R0x06] row-times.

When STANDBY is asserted during the vertical blanking period (FRAME_VALID is LOW), the STANDBY signal must not change state between [Vertical Blanking Register (R0x06) - 5] row-times and [Vertical Blanking Register + 5] row-times after the falling edge of FRAME_VALID.

Figure 50: STANDBY Restricted Location



8000 S. Federal Way, P.O. Box 6, Boise, ID 83707-0006, Tel: 208-368-3900
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This data sheet contains minimum and maximum limits specified over the complete power supply and temperature range for production devices. Although considered final, these specifications are subject to change, as further product development and data characterization sometimes occur.

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Revision History

Rev. A, Production. 06/06

- Initial release

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